

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

General Description

The MAX2079 fully integrated octal ultrasound receiver is optimized for high channel count, high-performance portable and cart-based ultrasound systems. The easy-to-use integrated receiver allows the user to achieve high-end 2D and Doppler imaging capability using substantially less space and power. The highly compact low-noise amplifier (LNA), variable-gain amplifier (VGA), anti-alias filter (AAF), analog-to-digital converter (ADC), and digital highpass filter (HPF) achieve an ultra-low 2.8dB noise figure at $R_S = R_{IN} = 200\Omega$ with a very low 120mW per channel power dissipation at 50Msps. The full receive channel has been optimized for second-harmonic imaging with an exceptional 76dBFS SNR over a 2MHz bandwidth, and -70dBc second-harmonic distortion at $f_{RF} = 5\text{MHz}$ over the full receiver gain range. Near-carrier dynamic range has also been optimized for exceptional pulsed and color-flow Doppler performance under high-clutter conditions. The bipolar front-end and CMOS ADC achieve an exceptional near-carrier SNR of 137dBFS/Hz at 1kHz from a 5MHz tone for excellent low-velocity Doppler sensitivity.

The device also includes an octal CWD beamformer for a full Doppler solution. Separate mixers for each channel are available for optimal CWD sensitivity.

The MAX2079 octal ultrasound front-end is available in a small, 10mm x 10mm, CTBGA package and is specified over the 0°C to +70°C temperature range.

Applications

Medical Ultrasound Imaging
Sonar

Benefits and Features

- ◆ **Minimizes PCB Area and Design Cost**
 - ✧ 8 Full Channels of LNA, VGA, AAF, 12-Bit ADC, Digital HPF and CWD Mixer Beamformer in a Small, 10mm x 10mm CTBGA Package
- ◆ **Improves System Sensitivity**
 - ✧ Ultra-Low Full-Channel Noise Figure of 2.8dB at $R_S = R_{IN} = 200\Omega$
- ◆ **Improves System Dynamic Range**
 - ✧ 76dBFS Image Path SNR Over 2MHz Bandwidth at $f_{RF} = 5\text{MHz}$
 - ✧ 137dBFS/Hz Image Path SNR at 1kHz Offset from $f_{RF} = 5\text{MHz}$
- ◆ **Consumes Less Power**
 - ✧ Ultra-Low Power of Only 120mW per Full Channel in Imaging Mode at 50Msps
- ◆ **Selectable Active Input Impedance Matching of 50Ω, 100Ω, 200Ω, and 1kΩ**
- ◆ **Programmable VGA Output Clamp**
- ◆ **Integrated Selectable 3-Pole 9MHz, 10MHz, 15MHz, and 18MHz Butterworth Anti-Alias Filter**
- ◆ **Programmable, Digital Highpass, 2-Pole Filter**
- ◆ **Serial LVDS Digital Outputs**
- ◆ **Fast Recovery Low-Power Modes (< 2μs)**
- ◆ **Separate Channel I/Q CWD Mixers for Improved Dynamic Range and Sensitivity**

[Ordering Information](#) appears at end of data sheet.

For related parts and recommended products to use with this part, refer to www.maximintegrated.com/MAX2079.related.

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maximintegrated.com.

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

ABSOLUTE MAXIMUM RATINGS

V_{CC3}, V_{CC5} to GND.....-0.3V to +5.5V
 AVDD, OVDD to GND-0.3V to +2.1V
 V_{CC5} - V_{CC3} > -0.3V
 V_{REF}, LO+/-, GC+/- to GND.....-0.3V to (V_{CC3} + 0.3V)
 CI+/-, CQ+/- to GND-0.3V to +13V
 ZF-, IN-, AG to GND.....-0.3V to (V_{CC5} + 0.3V)
 INC_.....±20mA DC
 IN_ to AG.....-0.6V to +0.6V
 REFIO, CLKIN+/-, LOON to
 GND.....-0.3V to the lower of (V_{AVDD} + 0.3V) and +2.1V

OUT+/-, SDIO, SCLK, $\overline{\text{CS}}$, CLKOUT+/-, FRAME+/-,
 SHDN, CWD to GND-0.3V to the lower of (V_{OVDD} + 0.3V)
 and +2.1V
 CI+/-, CQ+/-, V_{CC5}, V_{CC3}, AVDD/OVDD, V_{REF} analog and
 digital control signals must be applied in this order.
 Input Differential Voltage.....2.0V_{P-P} differential
 Continuous Power Dissipation (T_A = +70°C)
 144-Bump CTBGA (derate 33.3mW/°C above +70°C)....3200mW
 Operating Case Temperature Range (Note 1)....0°C to +70°C
 Junction Temperature+150°C
 Storage Temperature Range.....-40°C to +150°C
 Soldering Temperature (reflow)+260°C

Note 1: T_C is the temperature on the bump of the package. T_A is the ambient temperature of the device and PCB.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

PACKAGE THERMAL CHARACTERISTICS (Note 2)

Junction-to-Ambient Thermal Resistance (θ_{JA})25°C/W
 Junction-to-Case Thermal Resistance (θ_{JC})7.7°C/W

Note 2: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

OCTAL ULTRASOUND FRONT-END SPECIFICATIONS

DC ELECTRICAL CHARACTERISTICS—VGA MODE (CWD BEAMFORMER OFF)

(V_{REF} = 2.5V, V_{CC3} = 3.13V to 3.47V, V_{CC5} = 4.5V to 5.25V, V_{AVDD} = V_{OVDD} = 1.7V to 1.9V, T_A = 0°C to +70°C, V_{GND} = 0V, SHDN = 0, CWD = 0, LOON = 0, f_{RF} = 5MHz, 50mV_{P-P}, ADC f_{CLK} = 50Msps, digital HPF set to 60/64, two poles, 15/16 digital gain, V_{GC+} - V_{GC-} = -3V (minimum gain), high LNA gain. Typical values are at V_{REF} = 2.5V, V_{CC3} = 3.3V, V_{CC5} = 4.75V, V_{AVDD} = V_{OVDD} = 1.8V, V_{GC+} - V_{GC-} = 0V, T_A = +25°C, unless otherwise noted.) (Note 3)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--------------------|--|-------|------|-------|-------|
| 3.3V Supply Voltage | V _{CC3} | V _{CC3} pins | 3.13 | 3.3 | 3.47 | V |
| 5V Supply Voltage | V _{CC5} | V _{CC5} pins | 4.5 | 4.75 | 5.25 | V |
| 1.8V Supply Voltage | V _{CC1.8} | AVDD and OVDD pins | 1.7 | 1.8 | 1.9 | V |
| External Reference Voltage Range | V _{REF} | (Note 4) | 2.475 | | 2.525 | V |
| External Reference Current | | Total current into the V _{REF} pin | | 5 | | μA |
| 3V Supply Current per Channel | I _{CC3} | Total I divided by 8, V _{GC+} - V _{GC-} = 0.4V | | 9.5 | 16 | mA |
| 5V Supply Current per Channel | I _{CC5} | Total I divided by 8 | | 6.4 | 9 | mA |
| 1.8V Supply Current per Channel | I _{CC1.8} | Total I divided by 8, AVDD + OVDD | | 32 | 37.9 | mA |
| | | Total I divided by 8, AVDD | | 20 | 22.8 | mA |
| | | Total I divided by 8, OVDD | | 12 | 15.1 | mA |
| DC Power per Channel | P _{NM} | V _{GC+} - V _{GC-} = -0.4V | | 120 | | mW |
| Differential Analog Control Voltage Range | VGAIN_RANG | V _{GC+} - V _{GC-} | | ±3 | | V |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

DC ELECTRICAL CHARACTERISTICS—VGA MODE (CWD BEAMFORMER OFF) (continued)

($V_{REF} = 2.5V$, $V_{CC3} = 3.13V$ to $3.47V$, $V_{CC5} = 4.5V$ to $5.25V$, $V_{AVDD} = V_{OVDD} = 1.7V$ to $1.9V$, $T_A = 0^{\circ}C$ to $+70^{\circ}C$, $V_{GND} = 0V$, $SHDN = 0$, $CWD = 0$, $LOON = 0$, $f_{RF} = 5MHz$, $50mV_{P-P}$, $ADC\ f_{CLK} = 50Msps$, digital HPF set to 60/64, two poles, 15/16 digital gain, $V_{GC+} - V_{GC-} = -3V$ (minimum gain), high LNA gain. Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|------------------------|--|-----|-------------------|-----|---------|
| 5V Supply Nap Current | I _{NP_5V_TOT} | SHDN = 1, nap mode (all 8 channels) | | 30 | | mA |
| 3V Supply Nap Current | I _{NP_3V_TOT} | SHDN = 1, nap mode (all 8 channels) | | 0.035 | | mA |
| 1.8V Supply Nap Current | | SHDN = 1, nap mode (all 8 channels) | | 40 | | mA |
| 5V Supply Power-Down Current | I _{PD_5V_TOT} | SHDN = 1, power-down mode (all 8 channels) | | 1 | | μA |
| 3V Supply Power-Down Current | I _{PD_3V_TOT} | SHDN = 1, power-down mode (all 8 channels) | | 1 | | μA |
| 1.8V Supply Power-Down Current | | SHDN = 1, power-down mode (all 8 channels) | | 0.38 | | mA |
| Common-Mode Voltage for Differential Analog Control | VGAIN_COMM | ($V_{GC+} - V_{GC-}$)/2 | | 1.65 $\pm 5\%$ | | V |
| Source/Sink Current for Gain Control Pins | I_ACONTROL | Per pin | | ± 1.6 | | μA |

AC ELECTRICAL CHARACTERISTICS—VGA MODE (CWD BEAMFORMER OFF)

($V_{REF} = 2.5V$, $V_{CC3} = 3.13V$ to $3.47V$, $V_{CC5} = 4.5V$ to $5.25V$, $V_{AVDD} = V_{OVDD} = 1.7V$ to $1.9V$, $T_A = 0^{\circ}C$ to $+70^{\circ}C$, $V_{GND} = 0V$, $SHDN = 0$, $CWD = 0$, $LOON = 0$, $f_{RF} = 5MHz$, $50mV_{P-P}$, $ADC\ f_{CLK} = 50Msps$, digital HPF set to 60/64, two poles, 15/16 digital gain, $V_{GC+} - V_{GC-} = -3V$ (minimum gain), high LNA gain. Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
|------------------------------------|---|-----|------|-----|----------|
| ADC Bits | | | 12 | | Bits |
| Minimum ADC Sample Rate | | | 25 | | Msps |
| Maximum ADC Sample Rate | | 50 | | | Msps |
| Mode-Select Response Time (Note 5) | CWD stepped from 0 to 1, DC stable within 10% | | 1 | | μs |
| | CWD stepped from 1 to 0, DC stable within 10% | | 1 | | |
| Input Impedance | 50 Ω mode, $f_{RF} = 2MHz$ | | 50 | | Ω |
| | 100 Ω mode, $f_{RF} = 2MHz$ | | 100 | | |
| | 200 Ω mode, $f_{RF} = 2MHz$ | | 200 | | |
| | 1k Ω mode, $f_{RF} = 2MHz$ | | 1000 | | |
| Noise Figure (High LNA Gain) | $R_S = R_{IN} = 50\Omega$, $V_{GC+} - V_{GC-} = +3V$ | | 4.8 | | dB |
| | $R_S = R_{IN} = 100\Omega$, $V_{GC+} - V_{GC-} = +3V$ | | 3.8 | | |
| | $R_S = R_{IN} = 200\Omega$, $V_{GC+} - V_{GC-} = +3V$ | | 2.8 | | |
| | $R_S = R_{IN} = 1000\Omega$, $V_{GC+} - V_{GC-} = +3V$ | | 2.5 | | |
| Noise Figure (Low LNA Gain) | $R_S = R_{IN} = 200\Omega$, $V_{GC+} - V_{GC-} = +3V$ | | 3.8 | | dB |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

AC ELECTRICAL CHARACTERISTICS—VGA MODE (CWD BEAMFORMER OFF) (continued)

($V_{REF} = 2.5V$, $V_{CC3} = 3.13V$ to $3.47V$, $V_{CC5} = 4.5V$ to $5.25V$, $V_{AVDD} = V_{OVDD} = 1.7V$ to $1.9V$, $T_A = 0^{\circ}C$ to $+70^{\circ}C$, $V_{GND} = 0V$, $SHDN = 0$, $CWD = 0$, $LOON = 0$, $f_{RF} = 5MHz$, $50mV_{P-P}$, $ADC\ f_{CLK} = 50Msps$, digital HPF set to 60/64, two poles, 15/16 digital gain, $V_{GC+} - V_{GC-} = -3V$ (minimum gain), high LNA gain. Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|---|------|-----------|------|---------|
| 8-Channel Correlated Noise Power | No input signal, ratio of 8-channel noise power to single-channel noise power | | 9.0 | | dB |
| | 5MHz signal applied to all 8 channels, $V_{GC+} - V_{GC-} = 0V$, $f_{RF} = 5MHz$ at -3dBFS, ratio of 8-channel noise power to single-channel noise power | | 8.5 | | |
| LNA Gain (Low LNA Gain) | | | 12.5 | | dB |
| LNA Gain (High LNA Gain) | | | 18.5 | | dB |
| Maximum Gain (High LNA Gain) | $V_{GC+} - V_{GC-} = +3V$ (max gain), LNA input to ADC Input | | 44.7 | | dB |
| Minimum Gain (High LNA Gain) | $V_{GC+} - V_{GC-} = -3V$ (min gain), LNA input to ADC Input | | 5.9 | | dB |
| Maximum Gain (Low LNA Gain) | $V_{GC+} - V_{GC-} = +3V$ (max gain), LNA input to ADC Input | | 40.4 | | dB |
| Minimum Gain (Low LNA Gain) | $V_{GC+} - V_{GC-} = -3V$ (min gain), LNA input to ADC input | | 1.4 | | dB |
| Gain Range | | | 38.8 | | dB |
| AA Filter 3dB Corner Frequency | 9MHz setting | | 9 | | MHz |
| | 10MHz setting | | 10 | | |
| | 15MHz setting | | 15 | | |
| | 18MHz setting | | 18 | | |
| AA Filter 3dB Corner Frequency Accuracy | | | ± 10 | | % |
| Digital Highpass Filter 3dB Corner Frequency | 2 poles, coefficients $R1 = R2 = 63/64$, $f_{CLK} = 50Msps$ | | 0.185 | | MHz |
| | 2 poles, coefficients $R1 = R2 = 54/64$, $f_{CLK} = 50Msps$ | | 1.736 | | |
| Clamp Level | Clamp on (V_{P-P} on AAF Output/ADC Input, digital HPF bypassed) | | 92 | | %FS |
| Device-to-Device Gain Matching | $T_A = +25^{\circ}C$, $V_{GC+} - V_{GC-} = -3V$ to $+3V$ (Note 6) | -1.6 | ± 0.5 | +1.6 | dB |
| Input Gain Compression | LNA = high gain, $V_{GC+} - V_{GC-} = -3V$ (VGA = min gain), gain ratio with $330mV_{P-P}/50mV_{P-P}$ input tones | | 0.7 | | dB |
| | LNA = low gain, $V_{GC+} - V_{GC-} = -3V$ (VGA = min gain), gain ratio with $600mV_{P-P}/50mV_{P-P}$ input tones | | 0.9 | | |
| VGA Gain Response Time | Gain step up ($V_{IN} = 5mV_{P-P}$, $V_{GC+} - V_{GC-}$ changed from -3V to +3V, settling time is measured within 1dB final value) | | 0.8 | | μs |
| | Gain step down ($V_{IN} = 5mV_{P-P}$, $V_{GC+} - V_{GC-}$ changed from -3V to +3V, settling time is measured within 1dB final value) | | 1.8 | | |
| VGA Output Offset Under Pulsed Overload | Over drive is $\pm 10mA$ in clamping diodes, $V_{GC+} - V_{GC-} = 1.0V$ (gain = 30dB), 16 pulses at 5MHz, repetition rate 20kHz; offset is measured at output when RF duty cycle is off | | < 3.3 | | %FS |
| Signal-to-Noise Over ADC Nyquist Band (25MHz) | $V_{OUT-} = -1dBFS$, $V_{IN} = 200mV_{P-P}$, $f_{RF} = 5MHz$ at -1dBFS, anti-alias filter = 9MHz, 50Msps sample rate | | 67 | | dBFS |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

AC ELECTRICAL CHARACTERISTICS—VGA MODE (CWD BEAMFORMER OFF) (continued)

($V_{REF} = 2.5V$, $V_{CC3} = 3.13V$ to $3.47V$, $V_{CC5} = 4.5V$ to $5.25V$, $V_{AVDD} = V_{OVDD} = 1.7V$ to $1.9V$, $T_A = 0^{\circ}C$ to $+70^{\circ}C$, $V_{GND} = 0V$, $SHDN = 0$, $CWD = 0$, $LOON = 0$, $f_{RF} = 5MHz$, $50mV_{P-P}$, $ADC\ f_{CLK} = 50Msps$, digital HPF set to 60/64, two poles, 15/16 digital gain, $V_{GC+} - V_{GC-} = -3V$ (minimum gain), high LNA gain. Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
|-------------------------------------|---|-----|-----------|-----|---------|
| Signal-to-Noise Over 2MHz Bandwidth | $V_{OUT-} = -1dBFS$, $V_{IN} = 200mV_{P-P}$, $f_{RF} = 5MHz$ at $-1dBFS$, anti-alias filter = 9MHz, 50Msps sample rate | | 76 | | dBFS |
| Near-Carrier Signal-to-Noise Ratio | $V_{GC+} - V_{GC-} = 0V$ (gain = 22dB), $f_{RF} = 5.3MHz$ at $-0.5dBFS$, measured at 1kHz from f_{RF} , 50Msps sample rate | | -137 | | dBFS/Hz |
| Second Harmonic (HD2) | $V_{IN} = 50mV_{P-P}$, $f_{RF} = 2MHz$, $ADC\ out = -3dBFS$ | | -71 | | dBc |
| | $V_{IN} = 50mV_{P-P}$, $f_{RF} = 5MHz$, $ADC\ out = -3dBFS$ | | -70 | | |
| IM3 Distortion | $V_{IN} = 50mV_{P-P}$, $f_{RF1} = 5MHz$, $f_{RF2} = 5.01MHz$ $ADC\ out = -3dBFS$ (Note 7) | | -54 | | dBc |
| Nap Mode Power-Up Response Time | $V_{GC+} - V_{GC-} = 0.6V$ (gain = 28dB), $f_{RF} = 5MHz$, $ADC\ out = -3dBFS$, settled with in 1dB from transition on $SHDN$ pin (includes ADC) | | 2 | | μs |
| Nap Mode Power-Down Response Time | To reach DC current target $\pm 10\%$, on V_{CC5} , V_{CC3} , $AVDD$, $OVDD$ from transition on $SHDN$ pin | | 4 | | μs |
| Sleep Mode Power-Up Response Time | $V_{GC+} - V_{GC-} = 0.6V$ (gain = 28dB), $f_{RF} = 5MHz$, $V_{OUT-} = -1dBFS$, settled within 1dB from transition on $SHDN$ | | 2 | | ms |
| Sleep Mode Power-Down Response Time | $V_{GC+} - V_{GC-} = 0.6V$ (gain = 28dB), $f_{RF} = 5MHz$, DC power reaches 1mW/channel, from transition on $SHDN$ (includes ADC) | | 4 | | ms |
| Adjacent-Channel Crosstalk | $V_{OUT-} = -3dBFS$, $f_{RF} = 5MHz$, $V_{GC+} - V_{GC-} = 0.6V$ (gain = 28dB) | | -60 | | dBc |
| Alternate-Channel Crosstalk | $V_{OUT-} = -3dBFS$, $f_{RF} = 5MHz$, $V_{GC+} - V_{GC-} = 0.6V$ (gain = 28dB) | | -80 | | dBc |
| Phase Matching Between Channels | $V_{GC+} - V_{GC-} = 0.6V$ (gain = 28dB), $f_{RF} = 5MHz$, $V_{OUT-} = -3dBFS$ | | ± 1.2 | | Degrees |

DC ELECTRICAL CHARACTERISTICS—CWD MODE (VGA, AAF, AND ADC OFF)

($V_{REF} = 2.5V$, $V_{CC3} = 3.13V$ to $3.47V$, $V_{CC5} = 4.5V$ to $5.25V$, $V_{AVDD} = V_{OVDD} = 1.7V$ to $1.9V$, $T_A = 0^{\circ}C$ to $+70^{\circ}C$, $V_{GND} = 0V$, $SHDN = 0$, $CWD = 1$, $LOON = 1$, $R_{IN} = 200\Omega$, high LNA gain, $Cl+$, $Cl-$, $CQ+$, $CQ-$ pulled up to $+11V$ through four separate 0.1% 120Ω resistors. No RF signals applied. Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|----------------|--|-----|----------------|-----|-------------------|
| Mixer LVDS LO Input Common-Mode Voltage | V_{LVDS_CM} | Pins $LO+$ and $LO-$ | | 1.25 ± 0.2 | | V |
| LVDS LO Differential Input Voltage | V_{LVDS_DM} | Common-mode input voltage = 1.25V (Note 8) | 200 | 700 | | mV _{P-P} |
| LVDS LO Input Common-Mode Current | I_{LVDS_CM} | Input bias current, common-mode input voltage = 1.25V (Note 8) | | 160 | | μA |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

DC ELECTRICAL CHARACTERISTICS—CWD MODE (VGA, AAF, AND ADC OFF) (continued)

(V_{REF} = 2.5V, V_{CC3} = 3.13V to 3.47V, V_{CC5} = 4.5V to 5.25V, V_{AVDD} = V_{OVDD} = 1.7V to 1.9V, T_A = 0°C to +70°C, V_{GND} = 0V, SHDN = 0, CWD = 1, LOON = 1, R_{IN} = 200Ω, high LNA gain, Cl+, Cl-, CQ+, CQ- pulled up to +11V through four separate 0.1% 120Ω resistors. No RF signals applied. Typical values are at V_{REF} = 2.5V, V_{CC3} = 3.3V, V_{CC5} = 4.75V, V_{AVDD} = V_{OVDD} = 1.8V, T_A = +25°C, unless otherwise noted.) (Note 3)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|---------------|--|-----|------|------|-------|
| LVDS LO Differential Input Resistance | R_LVDS_DM | (Note 9) | | 8 | | kΩ |
| FULL-POWER MODE | | | | | | |
| 5V Supply Current per Channel | I_C_5V_F | Total I divided by 8 | | 31.6 | 41 | mA |
| 3.3V Supply Current per Channel | I_C_3_3V_F | Total I divided by 8 | | 1.8 | 3 | mA |
| 1.8V Supply Current per Channel | I_C_1_8V_F | Total I divided by 8, AVDD + OVDD | | 6.3 | | mA |
| 11V Supply Current per Channel | I_C_11V_F | Total I divided by 8 | | 11.7 | 16.2 | mA |
| External Reference Current | | Total current into V _{REF} pin | | 70 | | μA |
| On-Chip Power Dissipation (All 8 Channels) | PDIS_FP_TOT_F | (Note 11) | | 2.1 | | W |
| On-Chip Power Dissipation per Channel | PDIS_FP_F | (Note 11) | | 260 | | mW |
| 5V Power-Down Current | | SHDN = 1, power-down mode (all 8 channels) | | 1 | | μA |
| 3V Power-Down Current | | SHDN = 1, power-down mode (all 8 channels) | | 1 | | μA |
| 1.8V Supply Power-Down Current | | SHDN = 1, power-down mode (all 8 channels) | | 0.38 | | mA |
| LOW-POWER MODE | | | | | | |
| 5V Supply Current per Channel | I_C_5V_L | Total I divided by 8 | | 27 | 35 | mA |
| 3.3V Supply Current per Channel | I_C_3_3V_L | Total I divided by 8 | | 1.8 | 3 | mA |
| 1.8V Supply Current per Channel | I_C_1_8V_L | Total I divided by 8, AVDD + OVDD | | 6.3 | | mA |
| 11V Supply current per channel | I_C_11V_L | Total I divided by 8 | | 7 | | mA |
| On-Chip Power Dissipation (All 8 Channels) | PDIS_FP_TOT_L | (Note 11) | | 1.6 | | W |
| On-Chip Power Dissipation per Channel | PDIS_FP_L | (Note 11) | | 200 | | mW |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

AC ELECTRICAL CHARACTERISTICS—CWD MODE (VGA, AAF, AND ADC OFF)

($V_{REF} = 2.5V$, $V_{CC3} = 3.13V$ to $3.47V$, $V_{CC5} = 4.5V$ to $5.25V$, $V_{AVDD} = V_{OVDD} = 1.7V$ to $1.9V$, $T_A = 0^{\circ}C$ to $+70^{\circ}C$, $V_{GND} = 0V$, $SHDN = 0$, $CWD = 1$, $SHDN = 0$, $LOON = 1$, $R_{IN} = 200\Omega$, $f_{RF} = 5MHz$, Source resistance $R_S = 200\Omega$, $Cl+$, $Cl-$, $CQ+$, $CQ-$ pulled up to $+11V$ through four separate 0.1% 120Ω resistors). The rise/fall time of the LVDS clock driving $LO+/LO-$ is required to be $0.5ns$, reference noise less than $10nV/\sqrt{Hz}$ from $1kHz$ to $20MHz$ (Note 10). Typical values are at $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
|-----------------------------------|---|-----|-----------|------|---------|
| CW DOPPER MIXER | | | | | |
| Mixer RF Frequency Range | | 0.9 | | 7.6 | MHz |
| LO Frequency Range | | 8.0 | | 60 | MHz |
| Mixer Output Frequency Range | | DC | | 100 | kHz |
| FULL-POWER MODE | | | | | |
| Noise Figure | No carrier | | 4.8 | | dB |
| SNR at 100mV _{P-P} Input | 100mV _{P-P} on input, $f_{RF} = f_{LO}/8 = 1.25MHz$, measured at 1kHz offset | | 146 | | dBc/Hz |
| SNR at 200mV _{P-P} Input | 200mV _{P-P} on input, $f_{RF} = f_{LO}/8 = 1.25MHz$, measured at 1kHz offset | | 151 | | dBc/Hz |
| IM3 Distortion | $V_{IN} = 100mV_{P-P}$, $f_{RF1} = 5MHz$, $f_{RF2} = 5.01MHz$, $f_{LO} = 8 \times 5MHz$ (Note 7) | | -57 | | dBc |
| Mixer Output-Voltage Compliance | Valid voltage range (AC + DC) on summed mixer output pins (Note 12) | 4.5 | | 12 | V |
| Channel-to-Channel Phase Matching | Measured under zero beat conditions. $V_{IN} = 100mV_{P-P}$, $f_{RF} = 5MHz$, $f_{LO}/8 = 5MHz$ | -1 | ± 0.5 | +1 | Degrees |
| Channel-to-Channel Gain Matching | Measured under zero beat conditions $V_{IN} = 100mV_{P-P}$, $f_{RF} = 5MHz$, $f_{LO}/8 = 5MHz$ | -1 | ± 0.5 | +1 | dB |
| Transconductance | $f_{LO}/8 = 1.25MHz$ (Note 13) | 19 | 23 | 26.5 | mS |
| LOW-POWER MODE | | | | | |
| Noise Figure | No carrier | | 4.8 | | dB |
| SNR at 100mV _{P-P} Input | 100mV _{P-P} on input, $f_{RF} = f_{LO}/8 = 1.25MHz$, measured at 1kHz offset | | 146 | | dBc/Hz |
| SNR at 200mV _{P-P} Input | 200mV _{P-P} on input, $f_{RF} = f_{LO}/8 = 1.25MHz$, measured at 1kHz offset | | 150 | | dBc/Hz |
| IM3 Distortion | $V_{IN} = 100mV_{P-P}$, $f_{RF1} = 5MHz$, $f_{RF2} = 5.01MHz$, $f_{LO} = 8 \times 5MHz$ (Note 7) | | -44 | | dBc |
| Mixer Output-Voltage Compliance | Valid voltage range (AC + DC) on summed mixer output pins (Note 12) | 4.5 | | 12 | V |
| Transconductance | $f_{LO}/8 = 1.25MHz$ (Note 13) | 18 | 22 | 25.5 | mS |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

ELECTRICAL CHARACTERISTICS—CLOCK AND TIMING

($V_{REF} = 2.5V$, $V_{CC3} = 3.13V$ to $3.47V$, $V_{CC5} = 4.5V$ to $5.25V$, $V_{AVDD} = V_{OVDD} = 1.7V$ to $1.9V$, $T_A = 0^{\circ}C$ to $+70^{\circ}C$, $V_{GND} = 0V$, $SHDN = 0$, $CWD = 0$, $LOON = 0$. $f_{RF} = 5MHz$, $50mV_{P-P}$, $ADC f_{CLK} = 50Msps$, digital HPF set to 60/64, two poles, 15/16 digital gain, $V_{GC+} - V_{GC-} = -3V$ (minimum gain), high LNA gain. Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | |
|---|--------------------|--|------------|-------|-------|------------------|----|
| CLOCK INPUTS (CLKIN+, CLKIN-), DIFFERENTIAL MODE | | | | | | | |
| Differential Clock Input Voltage | | | 0.4 to 2.0 | | | V _{P-P} | |
| Common-Mode Voltage | V _{CLKCM} | Self-biased | 1.2 | | | V | |
| | | DC-coupled clock signal | 1.0 to 1.4 | | | | |
| Input Resistance | R _{CLK} | Differential, default setting | 10 | | | kΩ | |
| | | Differential, programmable internal termination selected | 0.1 | | | | |
| | | Common mode to GND | 9 | | | | |
| Input Capacitance | C _{CLK} | Capacitance to GND, each input | 3 | | | pF | |
| CLOCK INPUTS (CLKIN+, CLKIN-), SINGLE-ENDED MODE (CLKIN- < 0.1V) | | | | | | | |
| Single-Ended Mode-Selection Threshold (CLKIN-) | | | 0.1 | | | V | |
| Single-Ended Clock Input High Threshold (CLKIN+) | | | 1.5 | | | V | |
| Single-Ended Clock Input Low Threshold (CLKIN+) | | | 0.3 | | | V | |
| Input Leakage (CLKIN+) | | V _{IH} = 1.8V | +5 | | | μA | |
| | | V _{IL} = 0V | -5 | | | | |
| Input Leakage (CLKIN-) | | V _{IL} = 0V | -150 | | | -50 | μA |
| Input Capacitance (CLKIN+) | | | 3 | | | pF | |
| DIGITAL INPUTS (CWD, LOON, SHDN, SCLK, SDIO, \overline{CS}) | | | | | | | |
| Input High Threshold | V _{IH} | | 1.5 | | | V | |
| Input Low Threshold | V _{IL} | | 0.3 | | | V | |
| Input Leakage | I _{IH} | V _{IH} = 1.8V | +5 | | | μA | |
| | I _{IL} | V _{IL} = 0V | -5 | | | | |
| Input Capacitance | C _{DIN} | | 3 | | | pF | |
| DIGITAL OUTPUTS (SDIO) | | | | | | | |
| Output Voltage Low | V _{OL} | I _{SINK} = 200μA | 0.2 | | | V | |
| Output Voltage High | V _{OH} | I _{SOURCE} = 200μA | OVDD - 0.2 | | | V | |
| LVDS DIGITAL OUTPUTS (OUT_+/-, CLKOUT+/-, FRAME+/-) (I = 3.5mA, VCM = 1.2V) | | | | | | | |
| Differential Output Voltage | V _{OD} | R _{LOAD} = 100Ω | 225 | 300 | 490 | mV | |
| Output Offset Voltage | V _{OS} | | 1.125 | 1.200 | 1.375 | V | |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

ELECTRICAL CHARACTERISTICS—CLOCK AND TIMING (continued)

($V_{REF} = 2.5V$, $V_{CC3} = 3.13V$ to $3.47V$, $V_{CC5} = 4.5V$ to $5.25V$, $V_{AVDD} = V_{OVDD} = 1.7V$ to $1.9V$, $T_A = 0^{\circ}C$ to $+70^{\circ}C$, $V_{GND} = 0V$, $SHDN = 0$, $CWD = 0$, $LOON = 0$. $f_{RF} = 5MHz$, $50mV_{P-P}$, ADC $f_{CLK} = 50Msps$, digital HPF set to 60/64, two poles, 15/16 digital gain, $V_{GC+} - V_{GC-} = -3V$ (minimum gain), high LNA gain. Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|------------|---|--------------------------|--------------------------|--------------------------|-------|
| SERIAL-PORT INTERFACE TIMING | | | | | | |
| SCLK Period | t_{SCLK} | | 50 | | | ns |
| SCLK-to- \overline{CS} Setup Time | t_{CSS} | | 10 | | | ns |
| SCLK-to- \overline{CS} Hold Time | t_{CSH} | | 10 | | | ns |
| SDIO-to-SCLK Setup Time | t_{SDS} | Serial-data write | 10 | | | ns |
| SDIO-to-SCLK Hold Time | t_{SDH} | Serial-data write | 0 | | | ns |
| SCLK-to-SDIO Output Data Delay | t_{SDD} | Serial-data read | | | 10 | ns |
| LVDS DIGITAL OUTPUT TIMING CHARACTERISTICS | | | | | | |
| Data Valid to CLKOUT_ Rise/Fall | t_{OD} | | $(t_{SAMPLE}/24) - 0.10$ | $(t_{SAMPLE}/24) + 0.05$ | $(t_{SAMPLE}/24) + 0.20$ | ns |
| CLKOUT_ Output-Width High | t_{CH} | | | $t_{SAMPLE}/12$ | | ns |
| CLKOUT_ Output-Width Low | t_{CL} | | | $t_{SAMPLE}/12$ | | ns |
| FRAME_ Rise to CLKOUT_ Rise | t_{DF} | | $(t_{SAMPLE}/24) - 0.10$ | $(t_{SAMPLE}/24) + 0.05$ | $(t_{SAMPLE}/24) + 0.20$ | ns |
| Sample CLKIN_ Rise to FRAME_ Rise | t_{SF} | | $(t_{SAMPLE}/2) + 1.6$ | $(t_{SAMPLE}/24) + 2.3$ | $(t_{SAMPLE}/2) + 3.3$ | ns |
| CWD LO TIMING | | | | | | |
| LOON Setup Time | t_{SU} | Setup time from LOON high to LVDS LO clock low-to-high transition | 5 | | | ns |

MAX2079

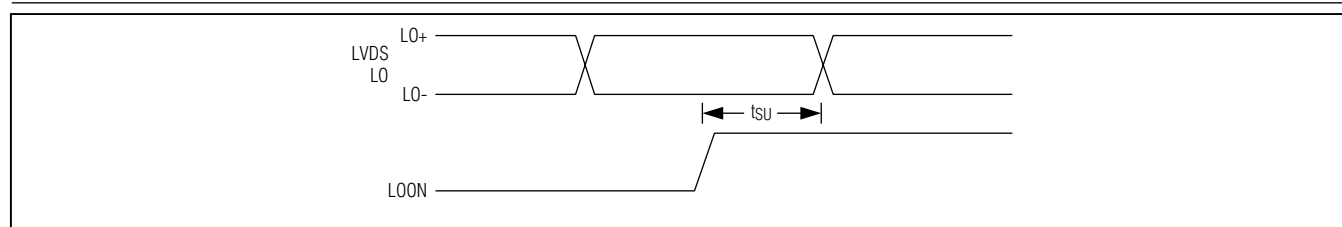
Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

ELECTRICAL CHARACTERISTICS—CLOCK AND TIMING (continued)

($V_{REF} = 2.5V$, $V_{CC3} = 3.13V$ to $3.47V$, $V_{CC5} = 4.5V$ to $5.25V$, $V_{AVDD} = V_{OVDD} = 1.7V$ to $1.9V$, $T_A = 0^{\circ}C$ to $+70^{\circ}C$, $V_{GND} = 0V$, $SHDN = 0$, $CWD = 0$, $LOON = 0$. $f_{RF} = 5MHz$, $50mV_{P-P}$, $ADC f_{CLK} = 50Msps$, digital HPF set to 60/64, two poles, 15/16 digital gain, $V_{GC+} - V_{GC-} = -3V$ (minimum gain), high LNA gain. Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

- Note 3:** Minimum and maximum limits at $T_A = +25^{\circ}C$ and $+70^{\circ}C$ are guaranteed by production test. Specifications for $T_A < +25^{\circ}C$ are guaranteed by design and/or characterization.
- Note 4:** Noise performance of the device is dependent on the noise contribution from V_{REF} . Use a low-noise supply for V_{REF} .
- Note 5:** This response time does not include the CW output highpass filter. When switching to VGA mode, the CW outputs stop drawing current and the output voltage goes to the rail. If a highpass filter is used, the recovery time can be excessive and a switching network is recommended.
- Note 6:** Specifications are guaranteed by design and characterization.
- Note 7:** See [Figure 22](#) in the [Ultrasound-Specific IMD3 Specification](#) section.
- Note 8:** The LVDS CWD LO inputs are DC-coupled. See the *CWD Beamformer Programming and Clocking* section for details of LO startup synchronization.
- Note 9:** An external 100Ω resistor terminates the LVDS differential signal path (LO+, LO-).
- Note 10:** The reference input noise is given for 8 channels, knowing that the reference-noise contributions are correlated in all 8 channels. If more channels are used, the reference noise must be reduced to get the best noise performance.
- Note 11:** Total on-chip power dissipation is calculated as $P_{DISS} = V_{CC5} \times I_{CC5} + V_{CC3} \times I_{CC3} + V_{AVDD} \times I_{AVDD} + V_{OVDD} \times I_{OVDD} + V_{REF} \times I_{REF} + [11V - (I_{11V}/4) \times 120] \times I_{11V}$. Additional power is dissipated through the off-chip 120Ω load resistors.
- Note 12:** Mixer output-voltage compliance is the range of acceptable voltages allowed on the CW mixer outputs.
- Note 13:** Transconductance is defined as the differential output current at baseband for each individual (I or Q) mixer output, divided by the single-ended RF input voltage directly on a single LNA input pin (IN_j). This can be calculated as $g_{mI} = (I_{CI+} - I_{CI-})/V_{INj}$ and $g_{mQ} = (I_{CQ+} - I_{CQ-})/V_{INj}$; or equivalently as $g_{mI} = (V_{CI+} - V_{CI-})/(R_L \times V_{INj})$ and $g_{mQ} = (I_{CQ+} - I_{CQ-})/(R_L \times V_{INj})$ (where $j = 1, 2, \dots, 8$ is a specific channel number, IN_j is a single LNA input pin, and R_L is the load resistance on each individual mixer output pin).

CWD LOON (LO On/Off) Timing Detail

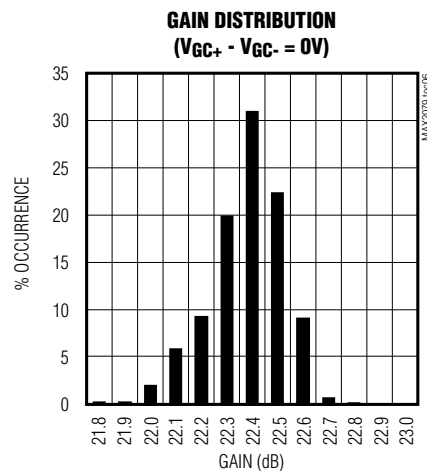
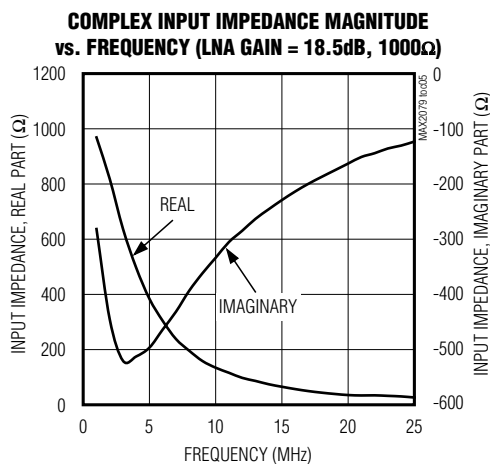
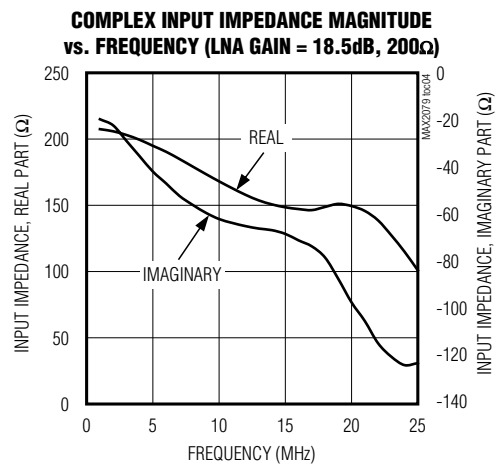
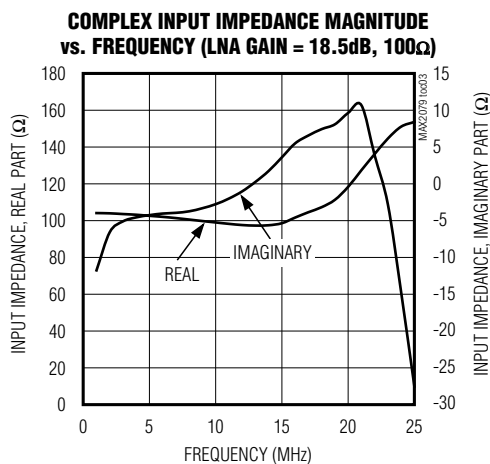
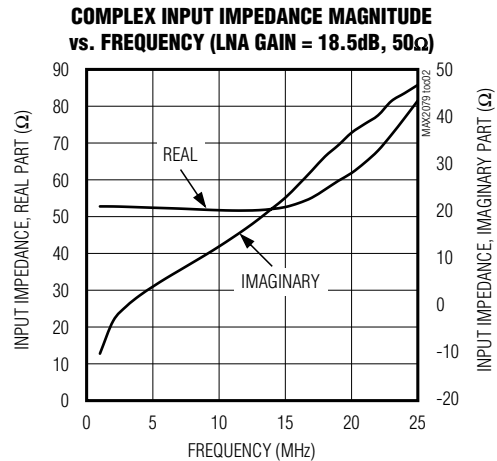
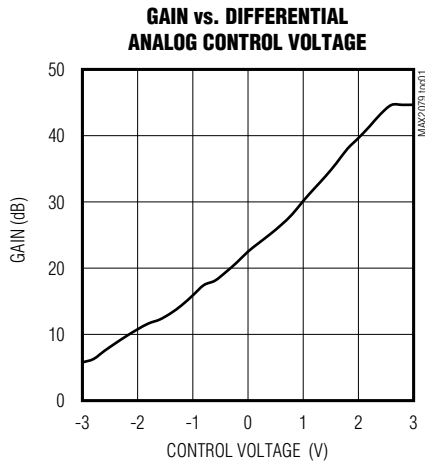


MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Typical Operating Characteristics

(Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)



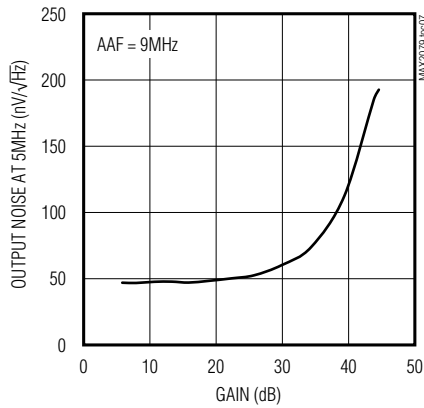
MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

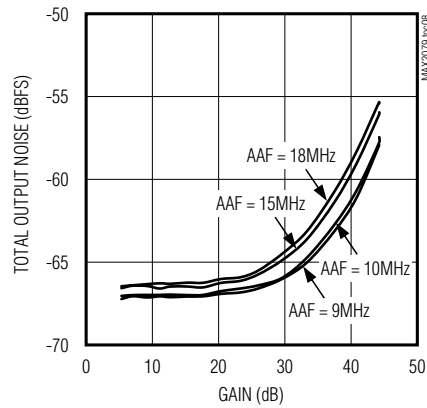
Typical Operating Characteristics (continued)

(Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

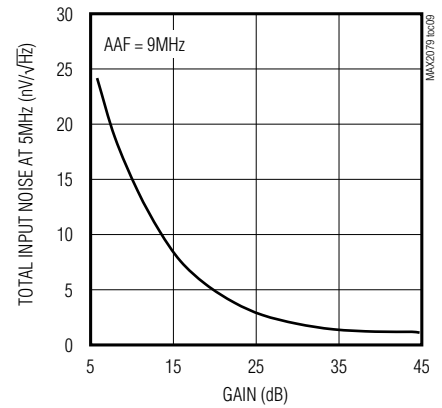
**TOTAL OUTPUT NOISE (AFE + ADC)
vs. GAIN**



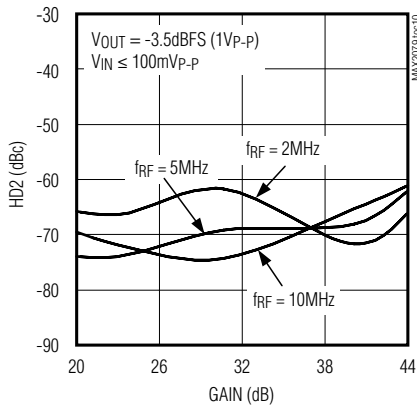
TOTAL OUTPUT NOISE vs. GAIN



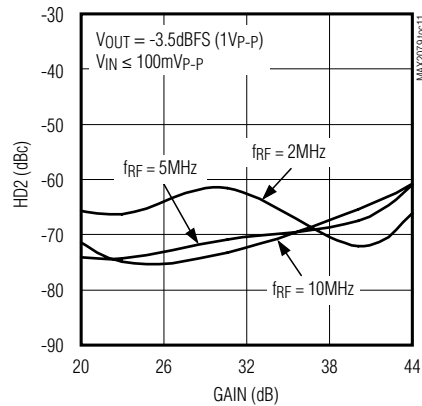
**TOTAL INPUT NOISE
(AFE + ADC) vs. GAIN**



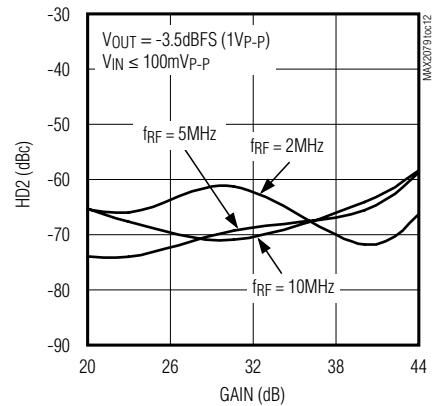
**SECOND-HARMONIC DISTORTION
vs. GAIN (AAF = 9MHz)**



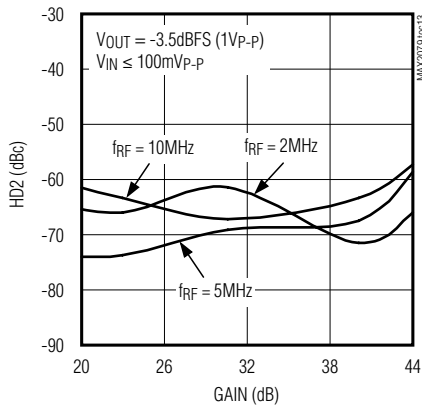
**SECOND-HARMONIC DISTORTION
vs. GAIN (AAF = 10MHz)**



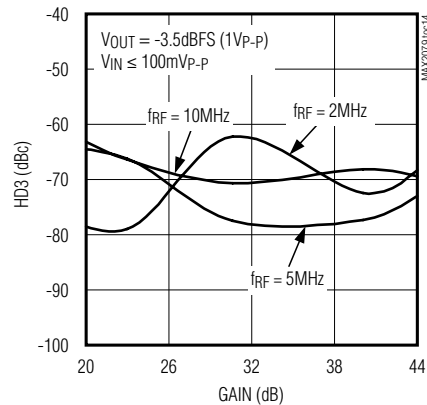
**SECOND-HARMONIC DISTORTION
vs. GAIN (AAF = 15MHz)**



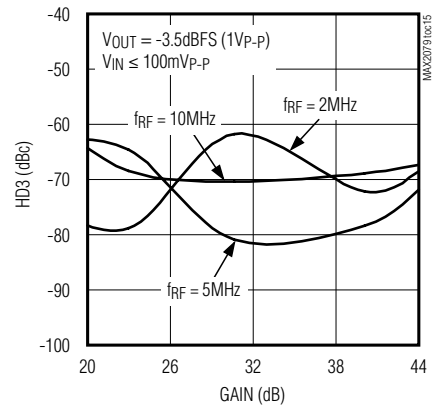
**SECOND-HARMONIC DISTORTION
vs. GAIN (AAF = 18MHz)**



**THIRD-HARMONIC DISTORTION
vs. GAIN (AAF = 9MHz)**



**THIRD-HARMONIC DISTORTION
vs. GAIN (AAF = 10MHz)**

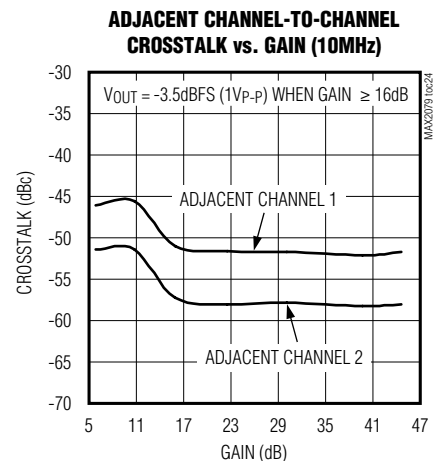
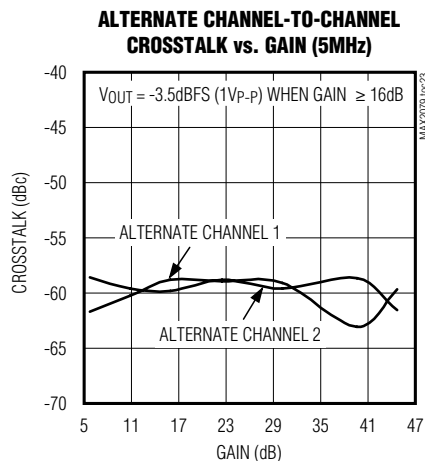
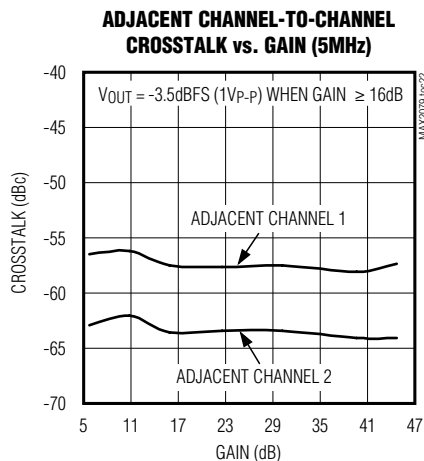
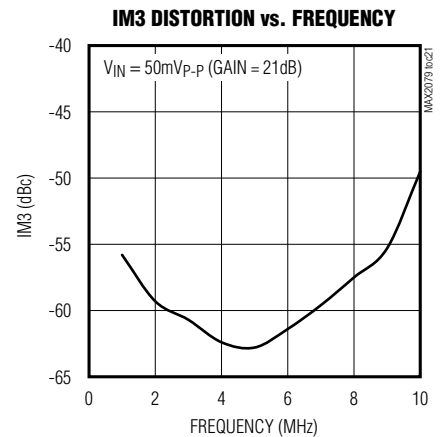
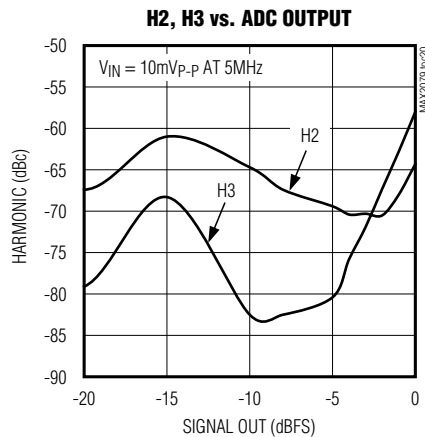
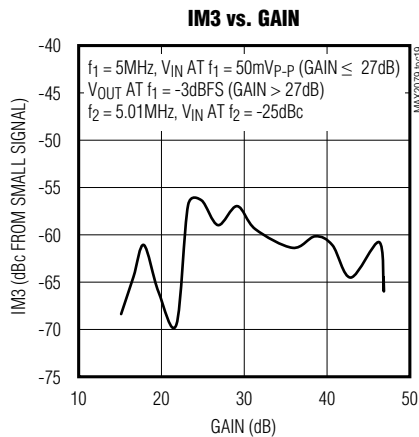
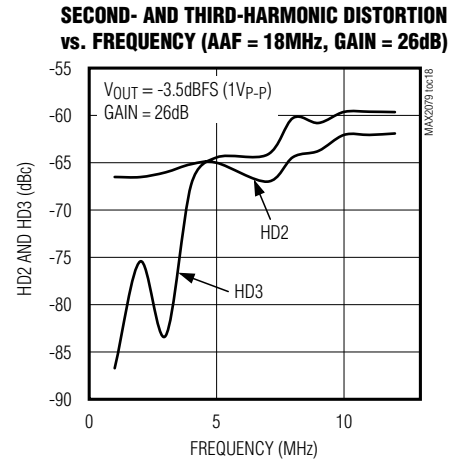
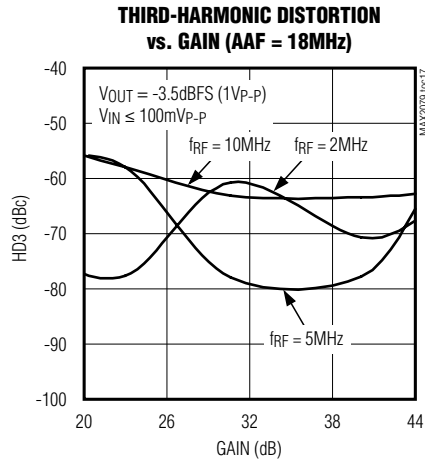
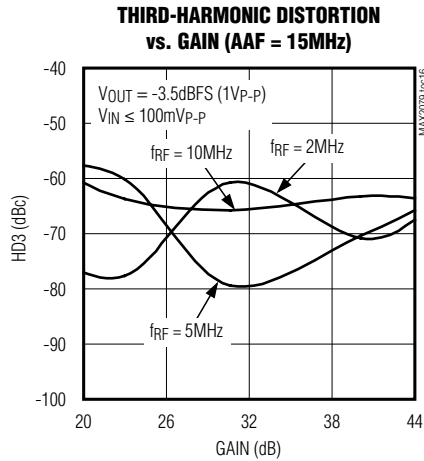


MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Typical Operating Characteristics (continued)

(Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)



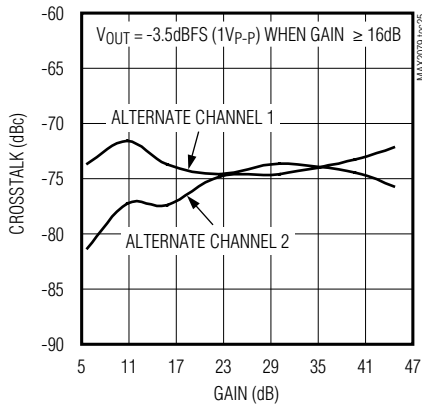
MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

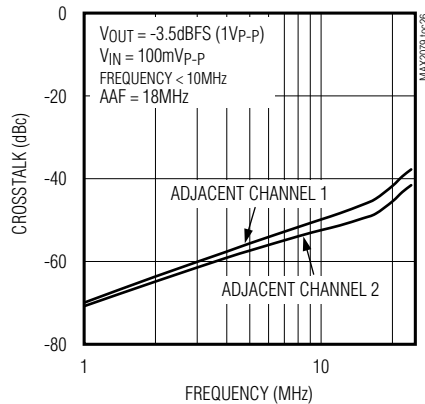
Typical Operating Characteristics (continued)

(Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

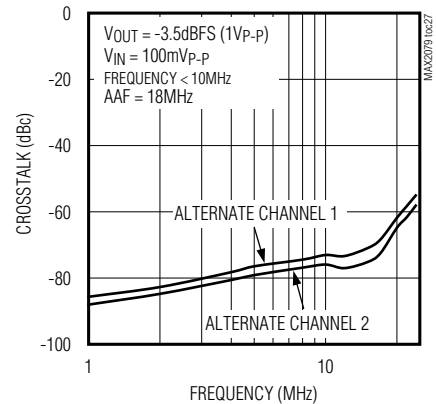
ALTERNATE CHANNEL-TO-CHANNEL CROSSTALK vs. GAIN (10MHz)



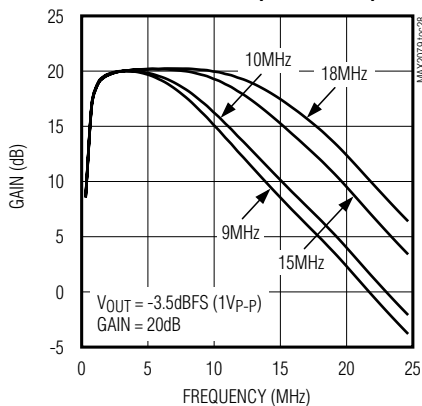
ADJACENT CHANNEL-TO-CHANNEL CROSSTALK vs. FREQUENCY



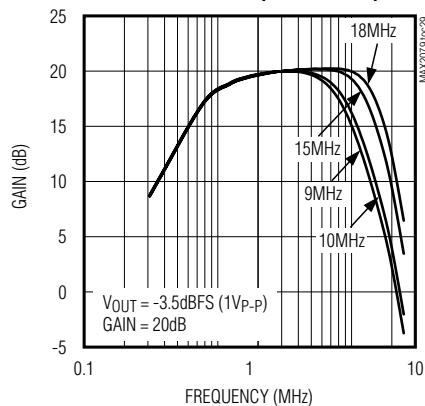
ALTERNATE CHANNEL-TO-CHANNEL CROSSTALK vs. FREQUENCY



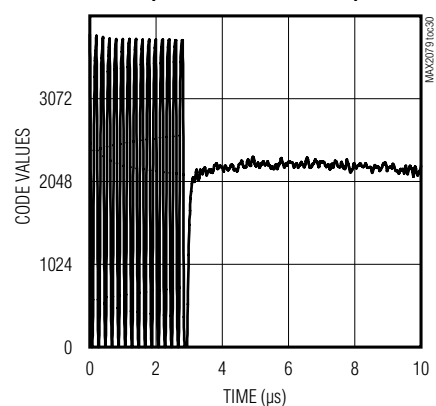
LARGE-SIGNAL BANDWIDTH vs. FREQUENCY (GAIN = 20dB)



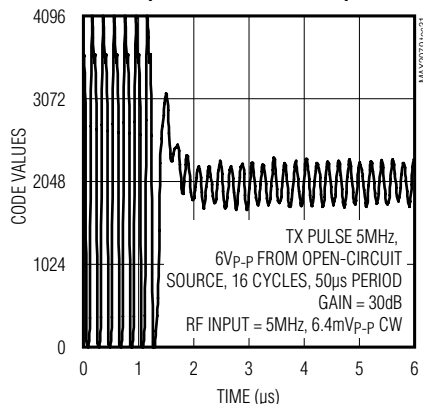
LARGE-SIGNAL BANDWIDTH vs. FREQUENCY (GAIN = 20dB)



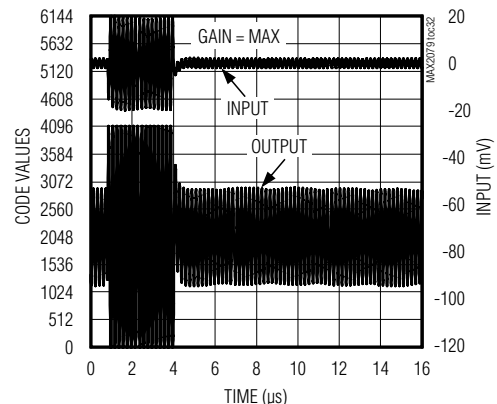
LNA OVERLOAD RECOVERY (DIGITAL HPF DISABLED)



LNA OVERLOAD RECOVERY (DIGITAL HPF ENABLED)



VGA OVERLOAD RECOVERY

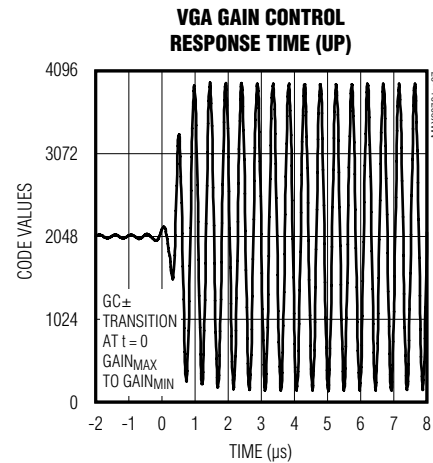
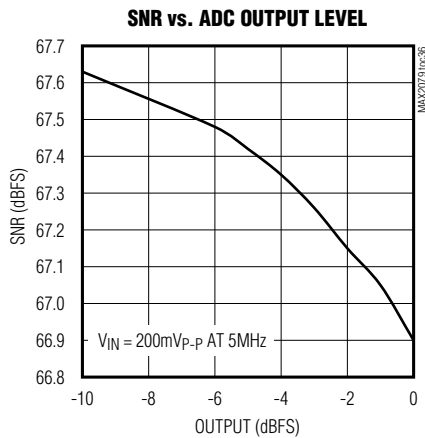
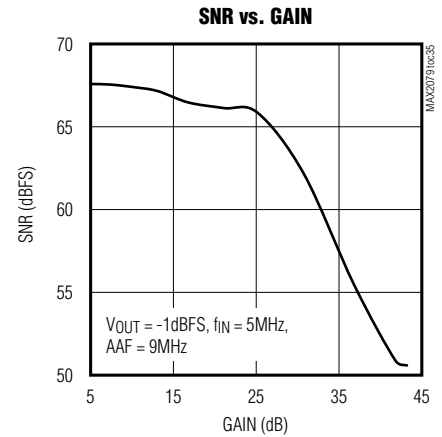
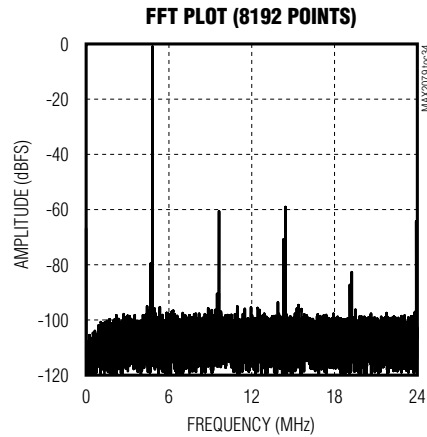
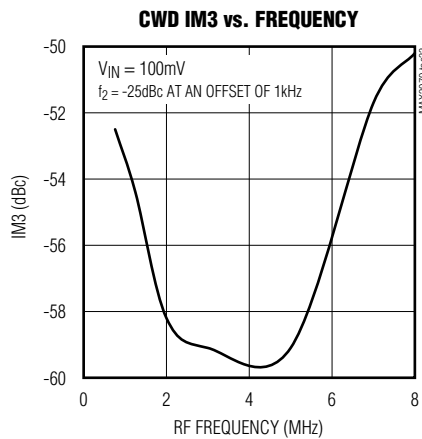


MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Typical Operating Characteristics (continued)

(Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

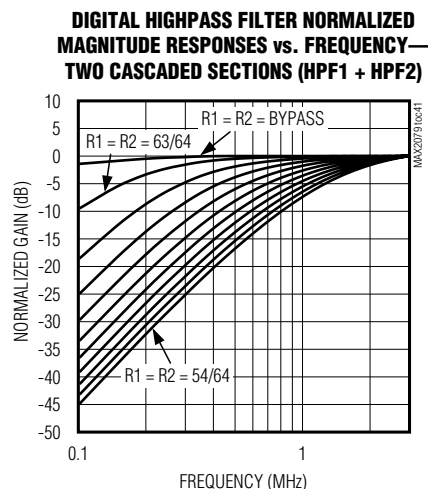
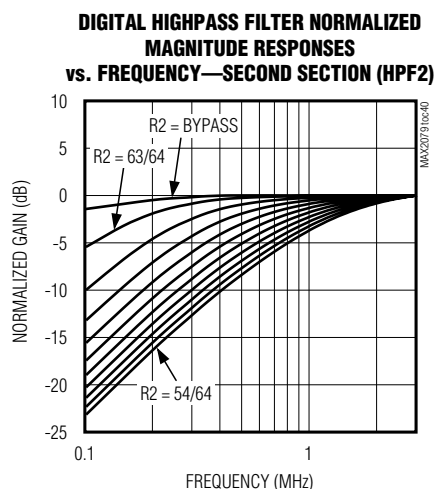
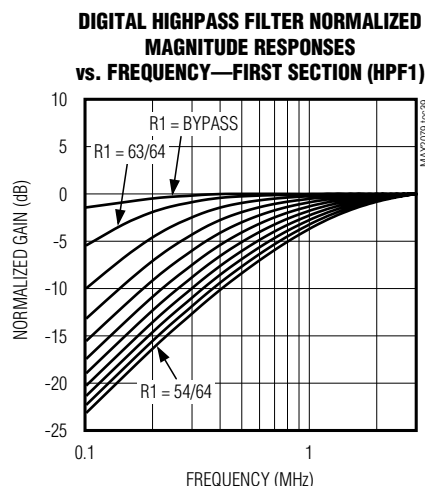
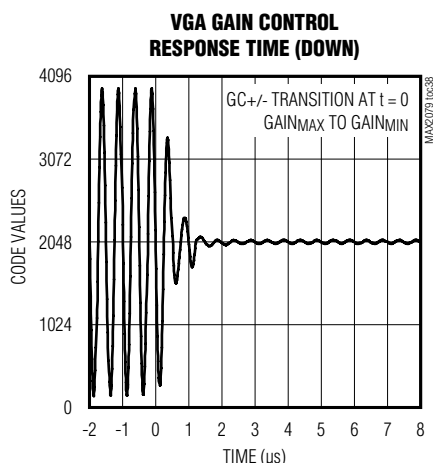


MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Typical Operating Characteristics (continued)

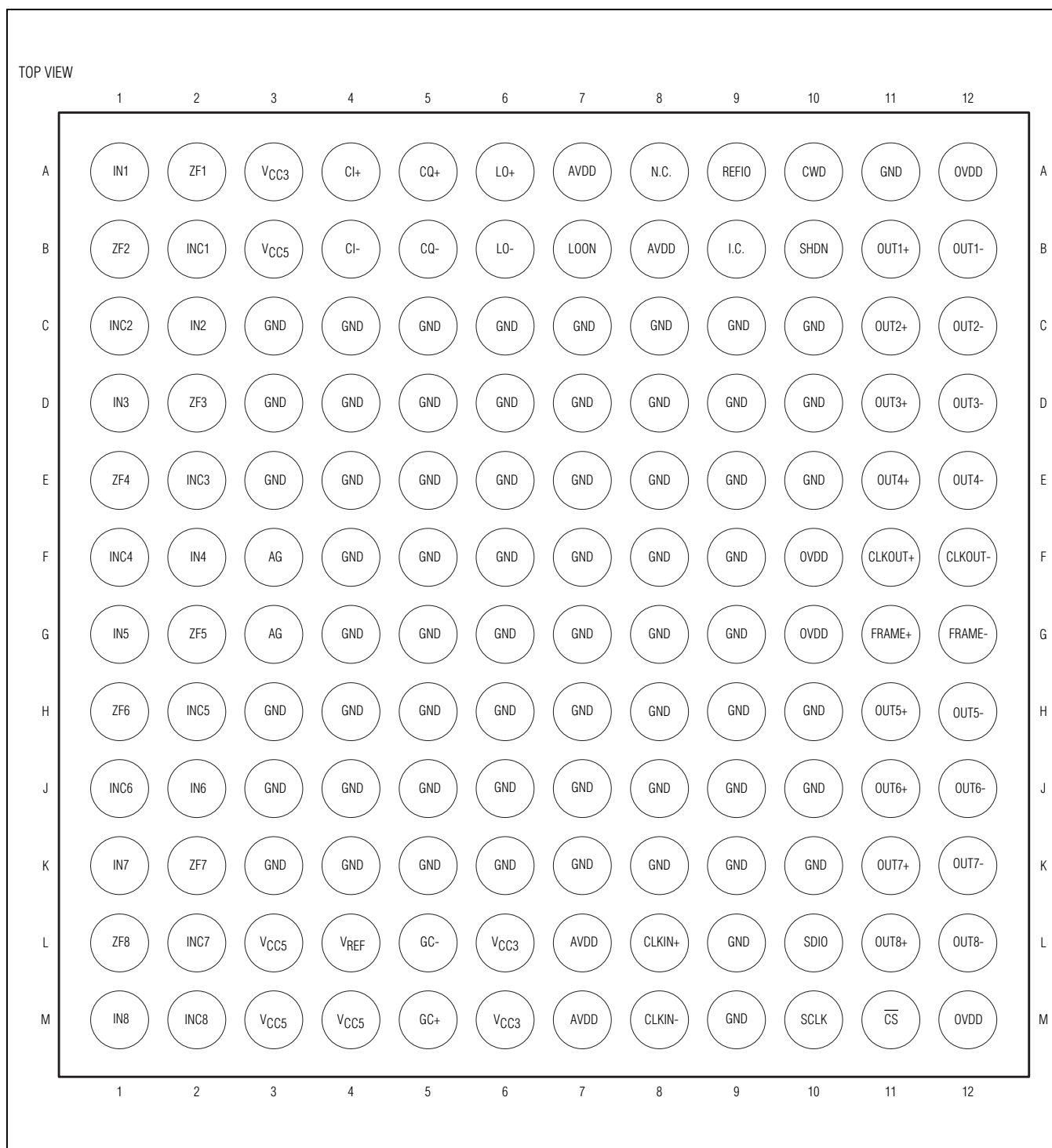
(Typical values are at $V_{REF} = 2.5V$, $V_{CC3} = 3.3V$, $V_{CC5} = 4.75V$, $V_{AVDD} = V_{OVDD} = 1.8V$, $V_{GC+} - V_{GC-} = 0V$, $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)



MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Bump Configuration



MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Bump Description

| BUMP | NAME | FUNCTION |
|---|-------|--|
| A1 | IN1 | Channel 1 Input. Connect to a 4.7nF coupling capacitor. |
| A2 | ZF1 | Channel 1 Active Impedance Matching Line. AC-couple to IN1 with a 2.2nF capacitor. |
| A3, L6, M6 | VCC3 | 3.3V Power-Supply Voltage. Bypass to GND with a 0.1μF capacitor as close as possible to the part. |
| A4 | CI+ | 8-Channel CW Positive In-Phase Output. Connect to 11V with a 120Ω external resistor. |
| A5 | CQ+ | 8-Channel CW Positive Quadrature Output. Connect to 11V with a 120Ω external resistor. |
| A6 | LO+ | Positive CW Local Oscillator Input. This clock is then divided in the beamformer. |
| A7, B8, L7, M7 | AVDD | 1.8V Analog ADC Power-Supply Voltage. Connect AVDD to a 1.7V to 1.9V power supply. Bypass AVDD to GND with a 0.1μF capacitor as close as possible to the device. |
| A8 | N.C. | No Connection. Internally not connected. |
| A9 | REFIO | I/O Reference (for Internal Calibration) |
| A10 | CWD | VGA/CW Mode Select. Set CWD low to enable the VGAs and disable the CW mixers. Set CWD high to enable the CW mixers and disable the VGAs. |
| A11, C3–C10, D3–D10, E3–E10, F4–F9, G4–G9, H3–H10, J3–J10, K3–K10, L9, M9 | GND | Ground |
| A12, F10, G10, M12 | OVDD | 1.8V Digital ADC Power-Supply Voltage. Bypass OVDD to GND with a 0.1μF capacitor as close as possible to the device. |
| B1 | ZF2 | Channel 2 Active Impedance Matching Line. AC-couple to IN2 with a 2.2nF capacitor. |
| B2 | INC1 | Channel 1 Clamp Input. Connect to the source side of the coupling capacitor. |
| B3, L3, M3, M4 | VCC5 | 4.75V Power-Supply Voltage. Bypass to GND with a 0.1μF capacitor as close as possible to the device. |
| B4 | CI- | 8-Channel CW Negative In-Phase Output. Connect to 11V with a 120Ω external resistor. |
| B5 | CQ- | 8-Channel CW Negative Quadrature Output. Connect to 11V with a 120Ω external resistor. |
| B6 | LO- | Negative CW Local Oscillator Input |
| B7 | LOON | LO On Control Input. Turns LO on starting on the next rising or falling edge of LO. |
| B9 | I.C. | Internally Connected. Leave unconnected. |
| B10 | SHDN | Power-Down (Nap or Sleep Mode Programmable through Serial Interface) |
| B11 | OUT1+ | Channel 1 Positive LVDS Output |
| B12 | OUT1- | Channel 1 Negative LVDS Output |
| C1 | INC2 | Channel 2 Clamp Input. Connect to the source side of the coupling capacitor. |
| C2 | IN2 | Channel 2 Input. Connect to a 4.7nF coupling capacitor. |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Bump Description (continued)

| BUMP | NAME | FUNCTION |
|--------|------------------|--|
| C11 | OUT2+ | Channel 2 Positive LVDS Output |
| C12 | OUT2- | Channel 2 Negative LVDS Output |
| D1 | IN3 | Channel 3 Input. Connect to a 4.7nF coupling capacitor. |
| D2 | ZF3 | Channel 3 Active Impedance Matching Line. AC-couple to IN3 with a 2.2nF capacitor. |
| D11 | OUT3+ | Channel 3 Positive LVDS Output |
| D12 | OUT3- | Channel 3 Negative LVDS Output |
| E1 | ZF4 | Channel 4 Active Impedance Matching Line. AC-couple to IN4 with a 2.2nF capacitor. |
| E2 | INC3 | Channel 3 Clamp Input. Connect to the source side of the coupling capacitor. |
| E11 | OUT4+ | Channel 4 Positive LVDS Output |
| E12 | OUT4- | Channel 4 Negative LVDS Output |
| F1 | INC4 | Channel 4 Clamp Input. Connect to the source side of the coupling capacitor. |
| F2 | IN4 | Channel 4 Input. Connect to a 4.7nF coupling capacitor. |
| F11 | CLKOUT+ | Positive LVDS Serial-Clock Output |
| F12 | CLKOUT- | Negative LVDS Serial-Clock Output |
| G1 | IN5 | Channel 5 Input. Connect to a 4.7nF coupling capacitor. |
| G2 | ZF5 | Channel 5 Active Impedance Matching Line. AC-couple to IN5 with a 2.2nF capacitor. |
| G3, F3 | AG | Analog Ground for LNA Inputs. Connect to a 47nF AC-coupling capacitor to ground. |
| G11 | FRAME+ | Positive Frame-Alignment LVDS Output |
| G12 | FRAME- | Negative Frame-Alignment LVDS Output |
| H1 | ZF6 | Channel 6 Active Impedance Matching Line. AC-couple to IN6 with a 2.2nF capacitor. |
| H2 | INC5 | Channel 5 Clamp Input. Connect to the source side of the coupling capacitor. |
| H11 | OUT5+ | Channel 5 Positive LVDS Output |
| H12 | OUT5- | Channel 5 Negative LVDS Output |
| J1 | INC6 | Channel 6 Clamp Input. Connect to the source side of the coupling capacitor. |
| J2 | IN6 | Channel 6 Input. Connect to a 4.7nF coupling capacitor. |
| J11 | OUT6+ | Channel 6 Positive LVDS Output |
| J12 | OUT6- | Channel 6 Negative LVDS Output |
| K1 | IN7 | Channel 7 Input. Connect to a 4.7nF coupling capacitor. |
| K2 | ZF7 | Channel 7 Active Impedance Matching Line. AC-couple to IN7 with a 2.2nF capacitor. |
| K11 | OUT7+ | Channel 7 Positive LVDS Output |
| K12 | OUT7- | Channel 7 Negative LVDS Output |
| L1 | ZF8 | Channel 8 Active Impedance Matching Line. AC-couple to IN8 with a 2.2nF capacitor. |
| L2 | INC7 | Channel 7 Clamp Input. Connect to the source side of the coupling capacitor. |
| L4 | V _{REF} | Voltage Reference |
| L5 | GC- | Negative Gain Control Voltage. Set V _{GC+} - V _{GC-} = +3V for maximum gain. Set V _{GC+} - V _{GC-} = -3V for minimum gain. |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

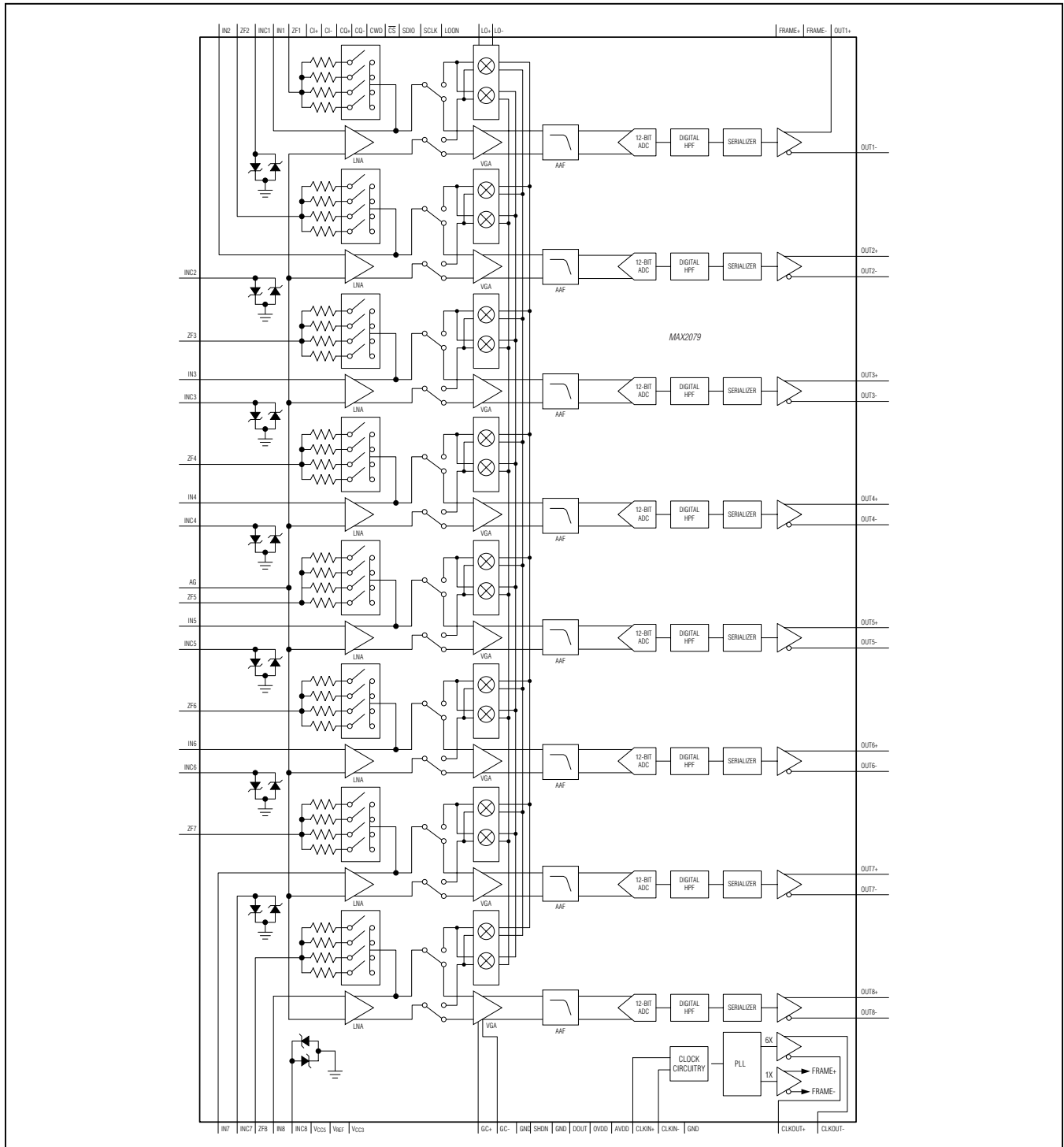
Bump Description (continued)

| BUMP | NAME | FUNCTION |
|------|-----------------|--|
| L8 | CLKIN+ | Positive Differential ADC Clock Input |
| L10 | SDIO | Serial-Data Input |
| L11 | OUT8+ | Channel 8 Positive LVDS Output |
| L12 | OUT8- | Channel 8 Negative LVDS Output |
| M1 | IN8 | Channel 8 Input. Connect to a 4.7nF coupling capacitor. |
| M2 | INC8 | Channel 8 Clamp Input. Connect to the source side of the coupling capacitor. |
| M5 | GC+ | Positive Gain Control Voltage. Set $V_{GC+} - V_{GC-} = +3V$ for maximum gain. Set $V_{GC+} - V_{GC-} = -3V$ for minimum gain. |
| M8 | CLKIN- | Negative Differential ADC Clock Input. Connect to 0V for a single-ended clock. |
| M10 | SCLK | Serial-Clock Input |
| M11 | \overline{CS} | Chip Select |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Functional Diagram



MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Detailed Description

Modes of Operation

The device requires programming before it can be used. The operating modes are controlled by 17 8-bit registers (00h to 10h). [Table 3](#) shows the functions of these programming registers.

Low-Noise Amplifier (LNA)

Each of the device's LNAs is optimized for excellent dynamic range and linearity performance characteristics, making it ideal for ultrasound imaging applications. When the LNA is placed in low-gain mode, the input resistance (R_{IN}), being a function of the gain A ($R_{IN} = R_F / (1 + A)$), increases by a factor of approximately 2. Consequently, the switches that control the feedback resistance (R_{FB}) have to be changed. For instance, the 100Ω mode in high gain becomes the 200Ω mode in low gain (see [Table 30](#)).

Variable-Gain Amplifier (VGA)

The device's VGAs are optimized for high linearity, high dynamic range, and low output-noise performance, all of which are critical parameters for ultrasound imaging applications. Each VGA path includes circuitry for adjusting analog gain, as well as an output buffer with differential output ports that drive the AAF and ADC. The VGA gain can be adjusted through the differential gain-control input (GC+ and GC-). Set the differential gain control input voltage at -3V for minimum gain and +3V for maximum gain. The differential analog control common-mode voltage is 1.65V (typ).

Overload Recovery

The device is also optimized for quick overload recovery for operation under the large input-signal conditions that are typically found in ultrasound input-buffer imaging applications. See the [Typical Operating Characteristics](#) for an illustration of the rapid recovery time from a transmit-related overload.

Dynamic offsets or DC offsets in the device can be removed by enabling the digital HPF function contained within the ADC. The unique structure of the digital HPF allows for the removal of up to $\pm 117\text{mV}$ of dynamic or static DC offset, without reducing the dynamic range of the ADC.

Octal Continuous-Wave (CW) Mixer

The device CW mixers are designed using an active double-balanced topology. The mixers achieve high dynamic range and high-linearity performance, with exceptionally low thermal and jitter noise, ideal for ultrasound CWD signal reception.

The octal array exhibits quadrature and in-phase differential current outputs (CQ+, CQ-, CI+, CI-) to produce the total CWD beamformed signal. The maximum differential current output is typically 3mA_{p-p} and the mixer output-compliance voltage ranges from 4.5V to 12V.

Each mixer can be programmed to 1 of 16 phases; therefore, 4 bits are required for each channel for programming.

Each CW channel can be programmed to an off state by setting bit CW_SHDN_CHn to 1. The power-down mode (SHDN) line overrides this soft shutdown.

After the serial shift registers have been programmed, the $\overline{\text{CS}}$ signal, when going high, loads the phase information in the form of 5 bits per channel into the I/Q phase divider/selectors. This presets the dividers, selecting the appropriate mixer phasing. See [Table 40](#) for mixer phase configurations.

CW Mixer Output Summation

The outputs from the octal-channel mixer array are summed internally to produce the total CWD summed beamformed signal. The octal array produces eight differential quadrature (Q) outputs and eight differential in-phase (I) outputs. All quadrature and in-phase outputs are summed into single I and Q differential current outputs (CQ+, CQ-, CI+, CI-).

CWD beamforming is achieved using a single $8 \times \text{LO}$ high-frequency master clock that is divided down to the CWD frequency using internal dividers. The beamformer provides $\lambda/16$ resolution with an $8 \times \text{LO}$ clock using both edges of the clock, assuming a 50% duty cycle. An easily available low-phase-noise 200MHz master clock can therefore be used to generate the necessary CWD frequencies with adequate resolution.

LO Phase Select

The LO phase dividers can be programmed through the shift registers to allow for 16 quadrature phases for a complete CW beamforming solution.

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

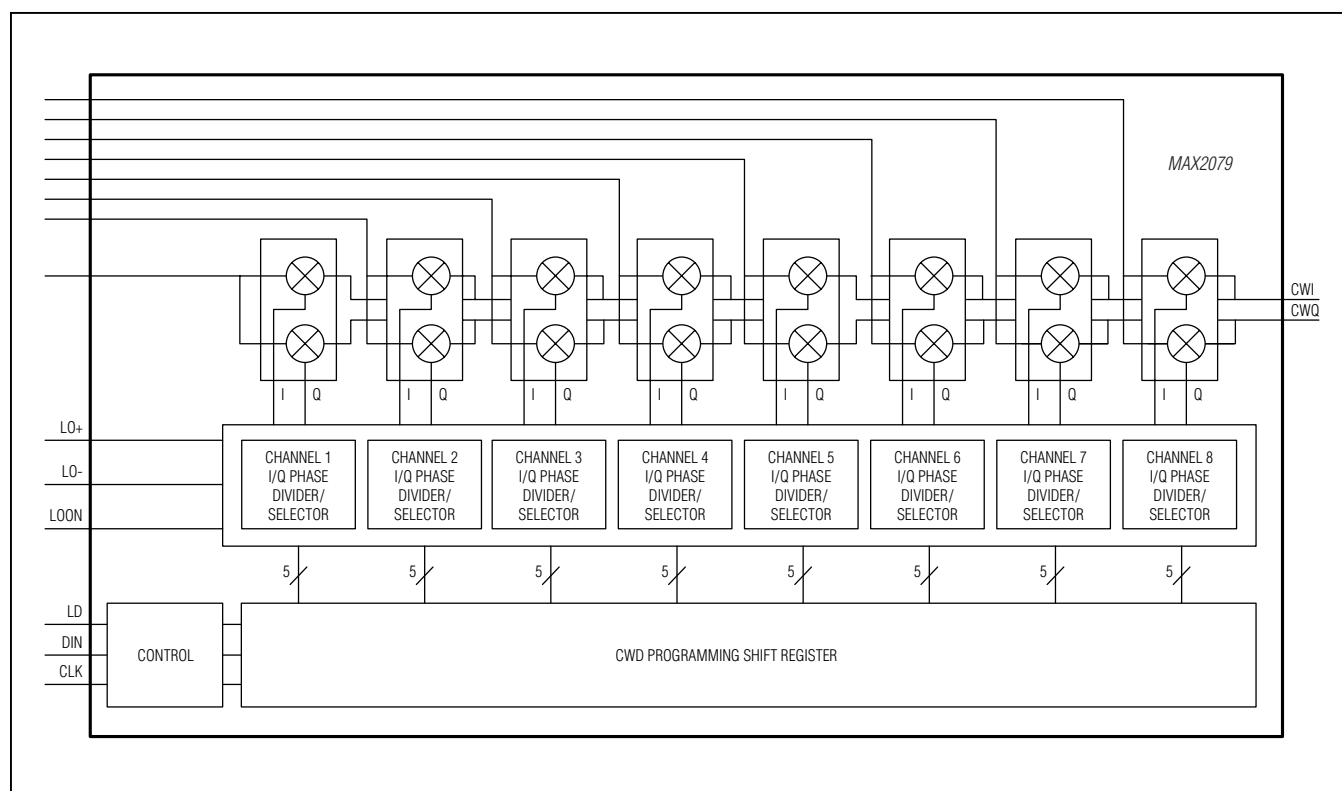


Figure 1. CWD Analog Front-End Beamformer Simplified Block Diagram

VGA and CW Mixer Operation

During normal operation, the device is configured so that either the VGA path is enabled while the mixer array is powered down (VGA mode), or the quadrature mixer array is enabled while the VGA path is powered down (CW mode). For VGA mode, set CWD to a logic-high, and for CW mode, set CWD to a logic-low.

External Voltage Reference

Connect an external, low-noise, +2.5V reference to the VREF pin. Bypass VREF to ground with a 0.1μF capacitor as close as possible to the device. The device noise performance is dependent on the external noise at VREF.

ADC Clock Input

The input clock interface provides for flexibility in the requirements of the clock driver. The device accepts a fully differential clock or single-ended logic-level clock. The device is specified for an input sampling 25MHz to 50MHz frequency range. By default, the internal phase-locked loop (PLL) is configured to accept input clock frequencies from 39MHz to 50MHz. The PLL is programmed through the PLL Sampling Rate register (00h, [Table 4](#)). [Table 5](#) details the complete range of PLL sampling frequency settings.

For differential clock operation, connect a differential clock to the CLKIN+ and CLKIN- inputs. The input

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

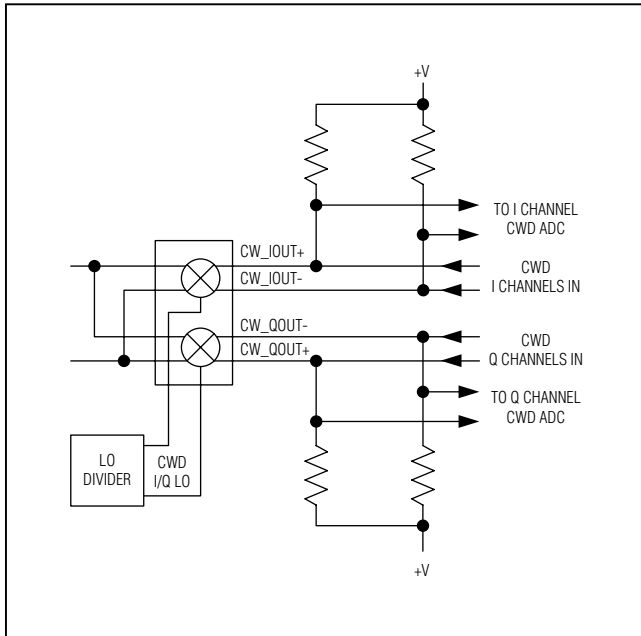


Figure 2. CWD Output Beamforming Example

common mode is established internally to allow for AC-coupling. The self-biased input common-mode voltage defaults to 1.2V. The differential clock signal can also be DC-coupled if the externally established common-mode voltage is constrained to the specified clock input common-mode range of 1V to 1.4V. A differential input termination of 100Ω can be switched in by programming the CLKIN Control register (04h[4], [Table 19](#)).

For single-ended operation, connect CLKIN- to GND and drive the CLKIN+ input with a logic-level signal. When the CLKIN- input is grounded (or pulled below the threshold of the clock-mode detection comparator), the differential-to-single-ended conversion stage is disabled and the logic-level inverter path is activated. The input common-mode self-bias is disconnected from CLKIN+, and provides a weak pullup bias to AVDD for CLKIN- during single-ended clock operation.

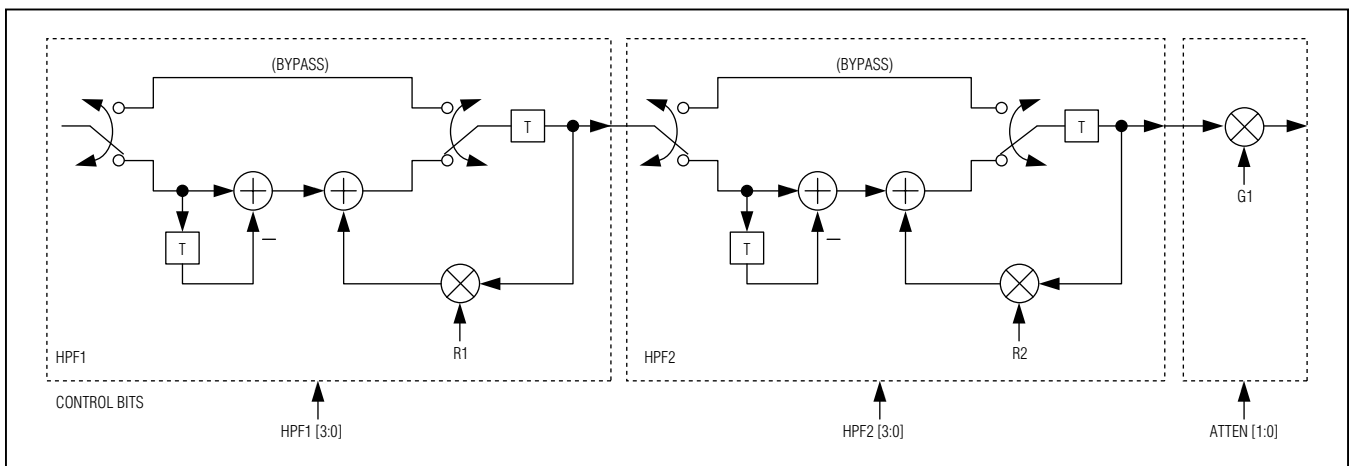


Figure 3. Digital Highpass Filter

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

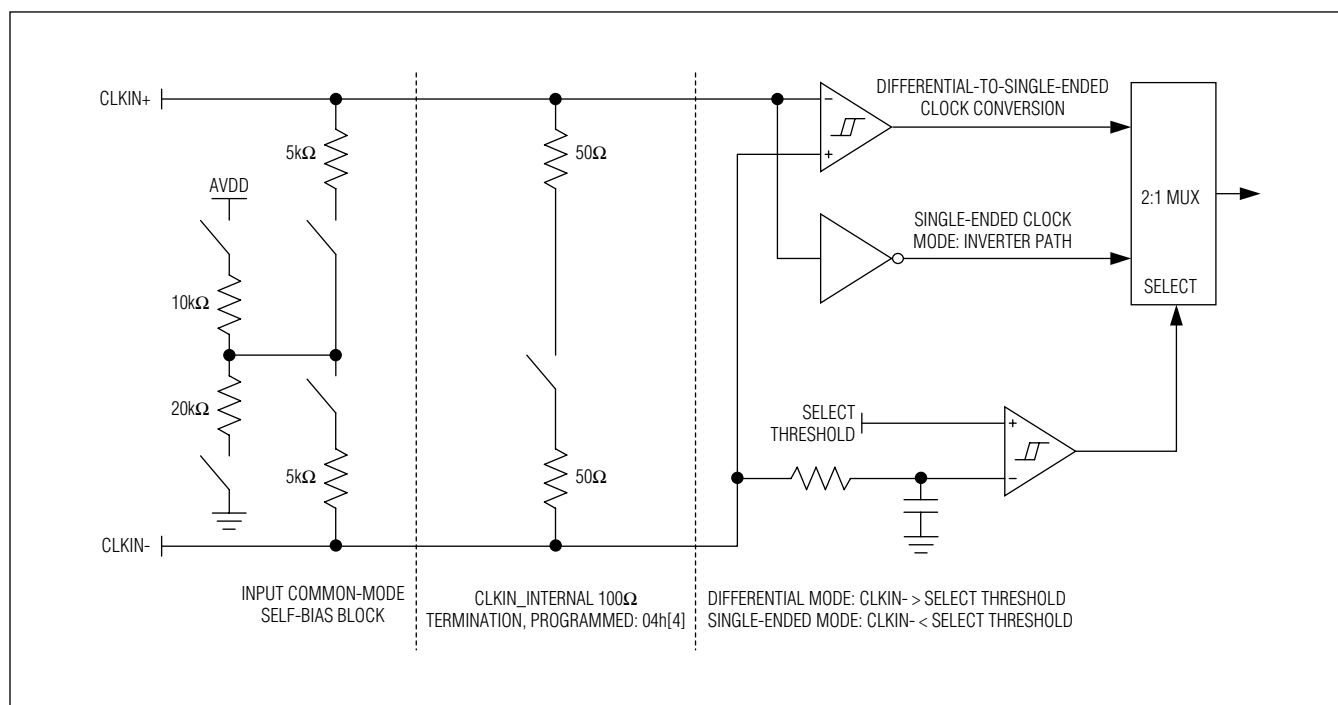


Figure 4. Simplified Clock Input Schematic

Power-Down and Low-Power Mode

The device can also be powered down with the SHDN pin. Set SHDN to +1.8V to place the device in power-down mode. In power-down mode, the device draws a total supply current less than 1μA from the 5V and 3.3V supplies, and less than 0.4mA from the 1.8V supplies. Set SHDN to logic-low for normal operation.

A low-power mode is available to lower the required power for CWD operation. When selected, the complex mixers operate at lower quiescent currents. Note that operation in this mode slightly reduces the dynamic performance of the device. [Table 6](#) shows the logic function of the standard operating modes.

In addition to power-down mode, the device can be placed into a reduced-power Standby or Nap mode, which allows for rapid power-up in VGA mode. Nap mode is accessible by setting the SHDN pin to +1.8V, with the ADC_NAP_SHDN1 and AFE_NAP_SHDN1 registers set to 1 (see [Table 6](#)). Nap mode is not meant to be used in conjunction with CWD mode; valid CWD power states are normal CWD low-power and power-down modes. Although no device damage occurs, programming the device for Nap mode and setting the SHDN pin high can create invalid signal outputs in CWD mode.

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Programmable, Digital Highpass 2-Pole Filter

Digital Highpass Filter Characteristics

This digital HPF is implemented as the cascade of two identical first-order highpass IIR filter sections. Each section implements the difference equation:

$$y[n] = R \times y[n - 1] + x[n] - x[n - 1]$$

Where $x[n]$ is the input and $y[n]$ is the output. The highpass 3dB corner frequency is established by the filter coefficient (R). Each section can be independently programmed to one of 10 possible values or placed into bypass mode. The available filter coefficient values and corresponding cutoff frequency are given in [Table 1](#).

Table 1. Digital Filter Cutoff-Frequency Setting

| FILTER COEFFICIENT (R) | | 3dB CUTOFF FREQUENCY ($f_s/2$) | 3dB CUTOFF FREQUENCY MHz ($f_s = 50\text{Mps}$) |
|----------------------------|----------|-------------------------------------|--|
| ONE-FILTER SECTIONS | | | |
| 54/64 | 0.843750 | 0.046294 | 1.157 |
| 55/64 | 0.859375 | 0.041943 | 1.049 |
| 56/64 | 0.875000 | 0.037535 | 0.938 |
| 57/64 | 0.890625 | 0.033069 | 0.827 |
| 58/64 | 0.906250 | 0.028544 | 0.714 |
| 59/64 | 0.921875 | 0.023956 | 0.599 |
| 60/64 | 0.937500 | 0.019303 | 0.483 |
| 61/64 | 0.953125 | 0.014584 | 0.365 |
| 62/64 | 0.968750 | 0.009796 | 0.245 |
| 63/64 | 0.984375 | 0.004935 | 0.123 |
| TWO-FILTER SECTIONS | | | |
| 54/64 | 0.843750 | 0.069441 | 1.736 |
| 55/64 | 0.859375 | 0.062915 | 1.573 |
| 56/64 | 0.875000 | 0.056303 | 1.408 |
| 57/64 | 0.890625 | 0.049604 | 1.240 |
| 58/64 | 0.906250 | 0.042816 | 1.070 |
| 59/64 | 0.921875 | 0.035934 | 0.898 |
| 60/64 | 0.937500 | 0.028955 | 0.724 |
| 61/64 | 0.953125 | 0.021876 | 0.547 |
| 62/64 | 0.968750 | 0.014694 | 0.367 |
| 63/64 | 0.984375 | 0.007403 | 0.185 |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

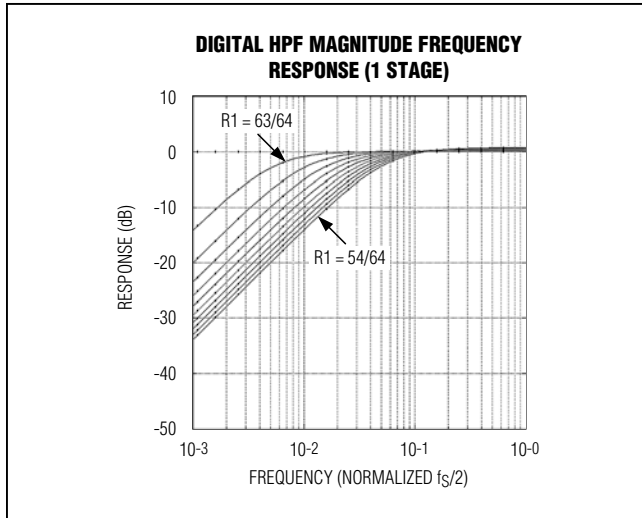


Figure 5. Digital HPF Magnitude Frequency Response (1 Stage)

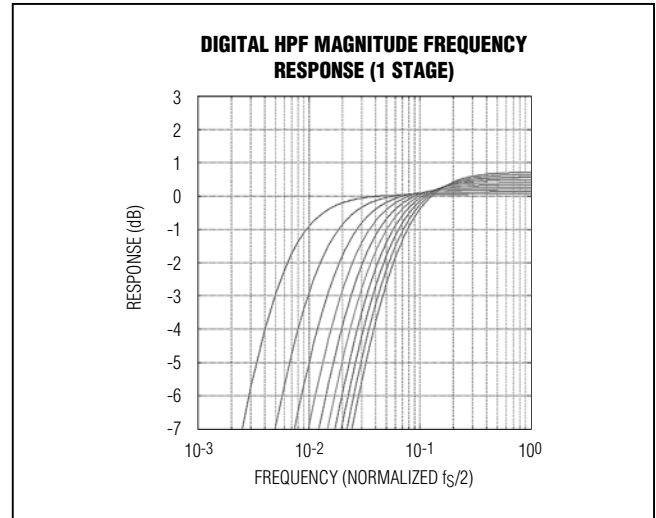


Figure 6. Digital HPF Magnitude Frequency Response (1 Stage)

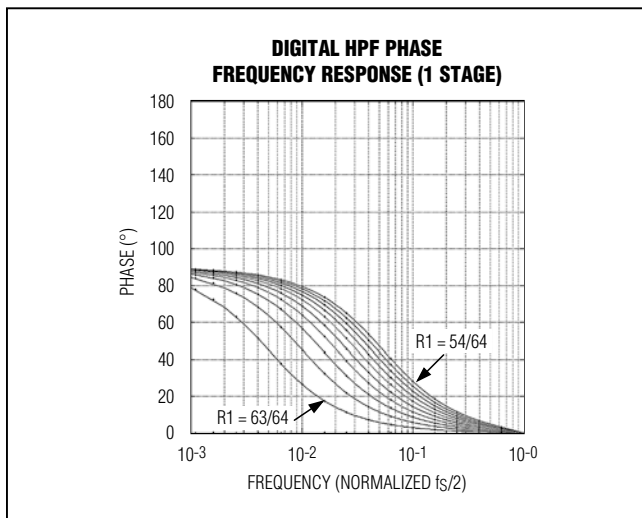


Figure 7. Digital HPF Phase Frequency Response (1 Stage)

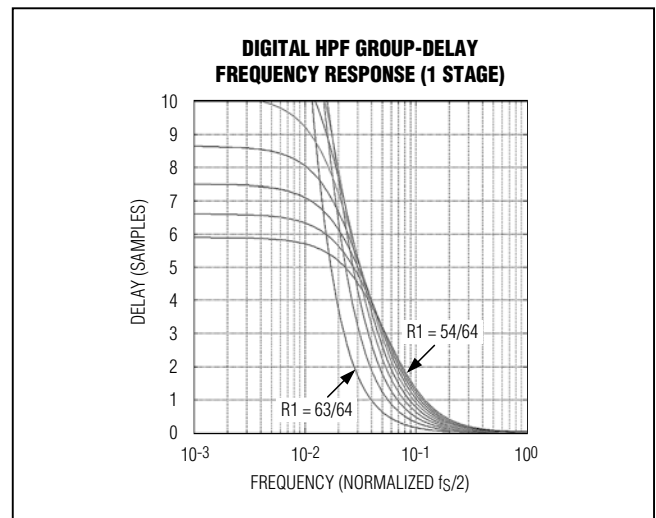


Figure 7a. Digital HPF Group-Delay Frequency Response (1 Stage)

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

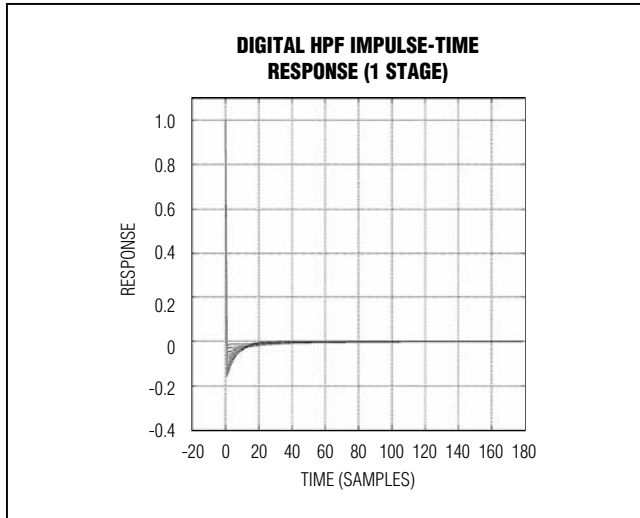


Figure 8. Digital HPF Impulse-Time Response (1 Stage)

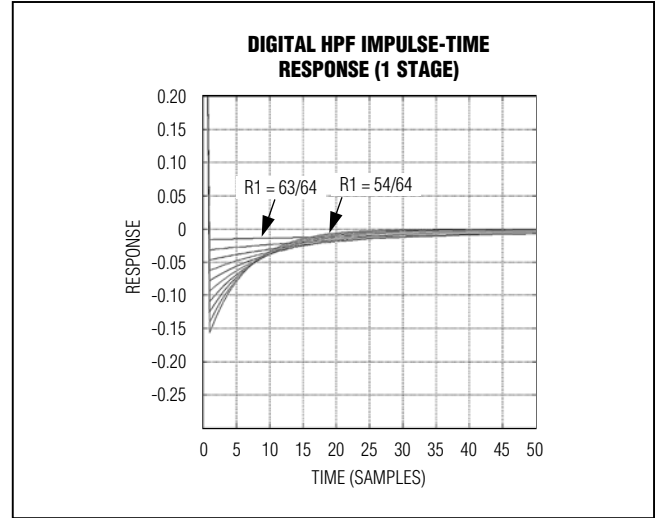


Figure 9. Digital HPF Impulse-Time Response (1 Stage)

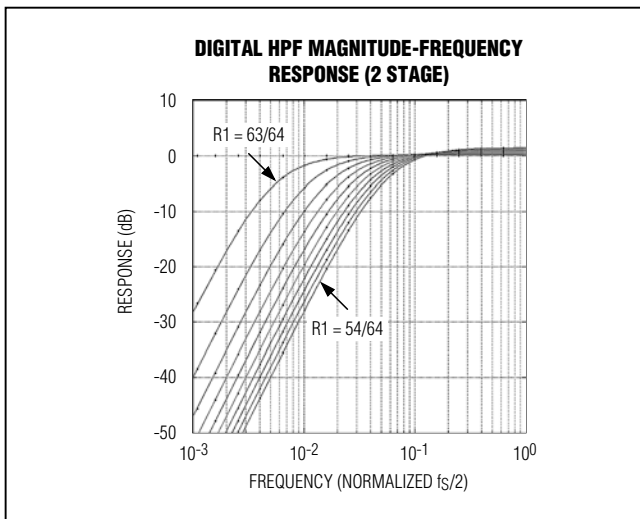


Figure 10. Digital HPF Magnitude-Frequency Response (2 Stage)

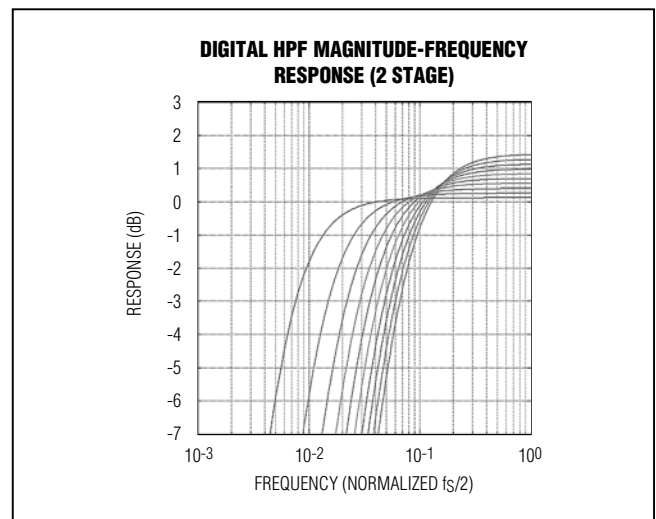


Figure 11. Digital HPF Magnitude-Frequency Response (2 Stage)

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

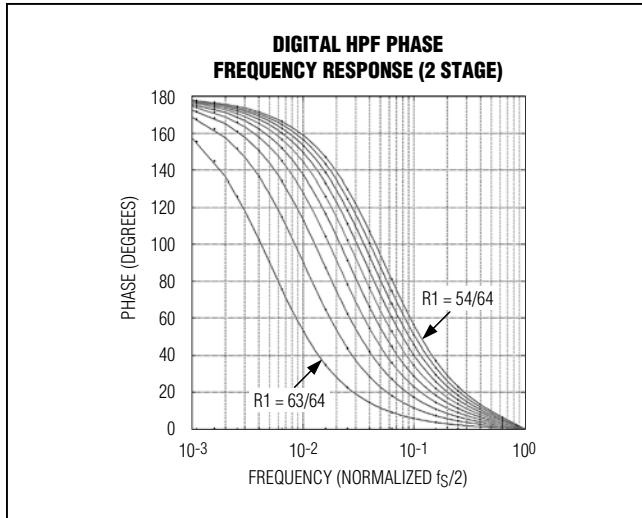


Figure 12. Digital HPF Phase Frequency Response (2 Stage)

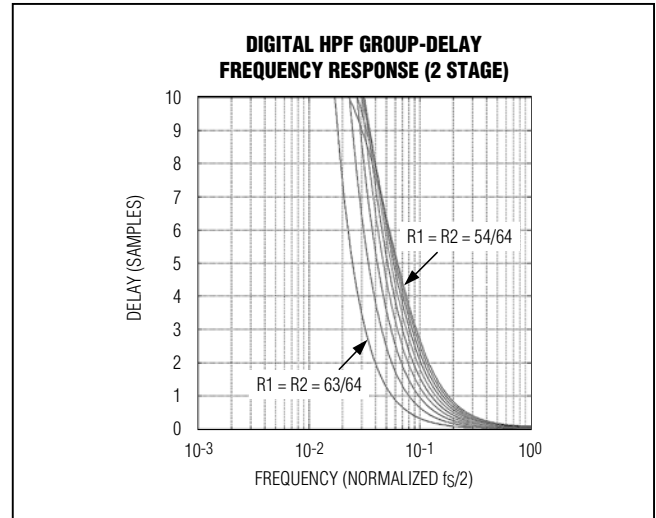


Figure 13. Digital HPF Group-Delay Frequency Response (2 Stage)

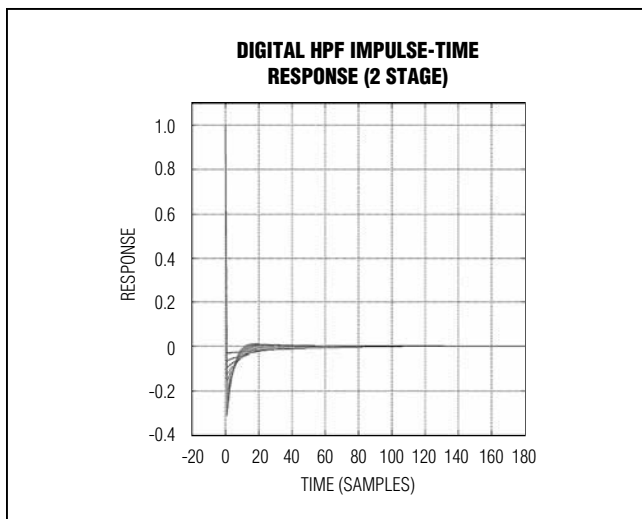


Figure 14. Digital HPF Impulse-Time Response (2 Stage)

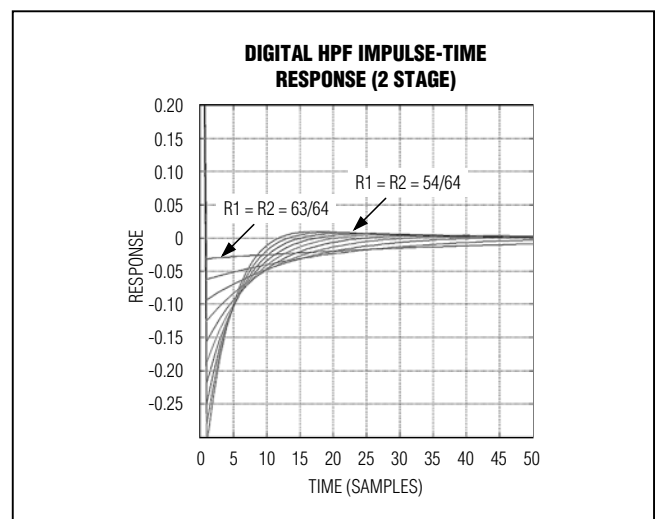


Figure 15. Digital HPF Impulse-Time Response (2 Stage)

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

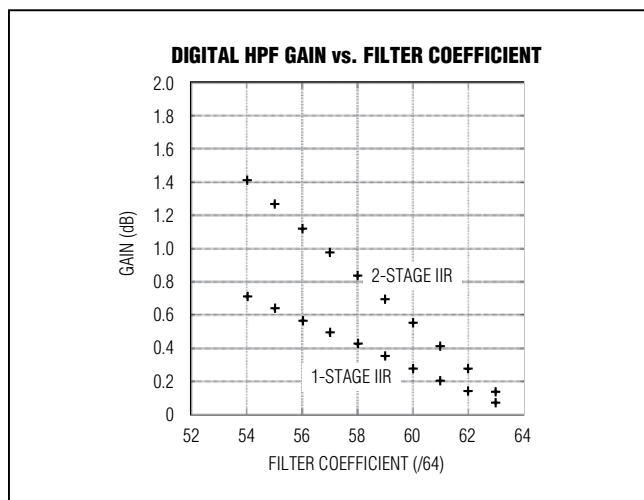


Figure 16. Digital HPF Gain vs. Filter Coefficient

The digital HPF provides a small-signal gain that depends on the filter coefficient. This effectively reduces slightly the full-scale input range of the ADC. A plot of filter gain vs. filter coefficient is shown in [Figure 16](#). A coarse digital multiplier is incorporated at the output of the filter to provide partial compensation of the digital filter gain.

[Table 2](#) provides the recommended gain-compensation settings for different filter cutoff-frequency settings.

Table 2. Gain-Compensation Settings for Different Filter Cutoff-Frequency Settings

| R | FILTER MODE | POLES | f_{3dB} ($f_S/2$) | GAIN | GAIN (dB) | GAIN COMP (dB) | OVERALL GAIN (dB) |
|--------|-------------|-------|-----------------------|-------|-----------|----------------|-------------------|
| N/A | Bypass | N/A | N/A | 1 | 0 | 0 | 0 |
| 63/64 | Filter | 1 | 0.004935 | 1 | 0.0681 | 0 | 0.0681 |
| 62/64 | Filter | 1 | 0.009796 | 1 | 0.1368 | 0 | 0.1368 |
| 61/64 | Filter | 1 | 0.014584 | 1 | 0.206 | 0 | 0.206 |
| 60/64 | Filter | 1 | 0.019303 | 1 | 0.2758 | 0 | 0.2758 |
| 59/64 | Filter | 1 | 0.023956 | 1 | 0.3461 | 0 | 0.3461 |
| 58/64 | Filter | 1 | 0.028544 | 15/16 | 0.417 | -0.5606 | -0.1436 |
| 57/64 | Filter | 1 | 0.033069 | 15/16 | 0.4885 | -0.5606 | -0.0721 |
| 56/64 | Filter | 1 | 0.037535 | 15/16 | 0.5606 | -0.5606 | 0 |
| 55/64 | Filter | 1 | 0.041943 | 15/16 | 0.6333 | -0.5606 | 0.0727 |
| 54/64 | Filter | 1 | 0.046294 | 15/16 | 0.7066 | -0.5606 | 0.146 |
| 63/64 | Filter | 2 | 0.007403 | 1 | 0.1362 | 0 | 0.1362 |
| 62/64 | Filter | 2 | 0.014694 | 1 | 0.2736 | 0 | 0.2736 |
| 61/64 | Filter | 2 | 0.021876 | 15/16 | 0.412 | -0.5606 | -0.1486 |
| 60/64* | Filter | 2 | 0.028955 | 15/16 | 0.5515 | -0.5606 | -0.0091 |
| 59/64 | Filter | 2 | 0.035934 | 15/16 | 0.6922 | -0.5606 | 0.1316 |
| 58/64 | Filter | 2 | 0.042816 | 15/16 | 0.834 | -0.5606 | 0.2734 |
| 57/64 | Filter | 2 | 0.049604 | 7/8 | 0.977 | -1.1598 | -0.1828 |
| 56/64 | Filter | 2 | 0.056303 | 7/8 | 1.1211 | -1.1598 | -0.0387 |
| 55/64 | Filter | 2 | 0.062915 | 7/8 | 1.2665 | -1.1598 | 0.1067 |
| 54/64 | Filter | 2 | 0.069441 | 7/8 | 1.4131 | -1.1598 | 0.2533 |

*Parts are factory trimmed with this setting. Programming can be changed.

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

System Timing Requirements

Figure 17 shows the relationship between the analog inputs, input clock, frame-alignment output, serial-clock output, and serial-data outputs. The differential ADC input signal is sampled on the rising edge of the applied

clock signal (CLKIN+, CLKIN-), and the resulting data appears at the digital outputs 10.5 clock cycles later. Figure 18 provides a detailed, two-conversion timing diagram of the relationship between inputs and outputs.

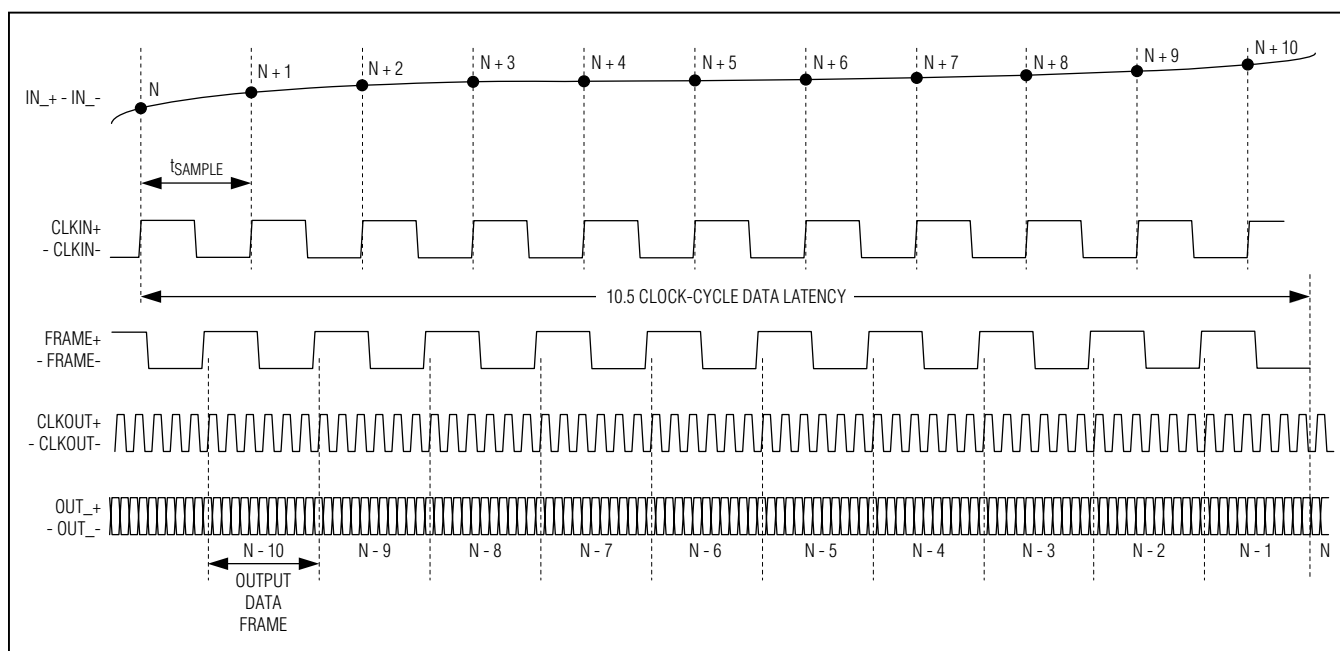


Figure 17. ADC Timing (Overall)

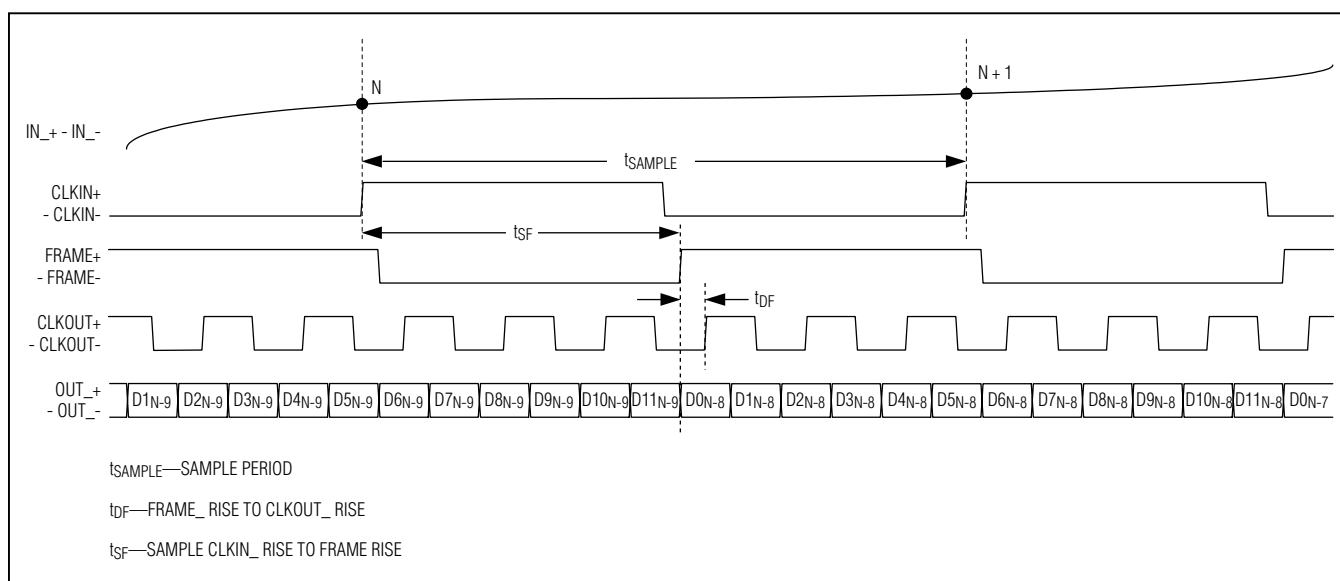


Figure 18. ADC Timing (Detail)

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

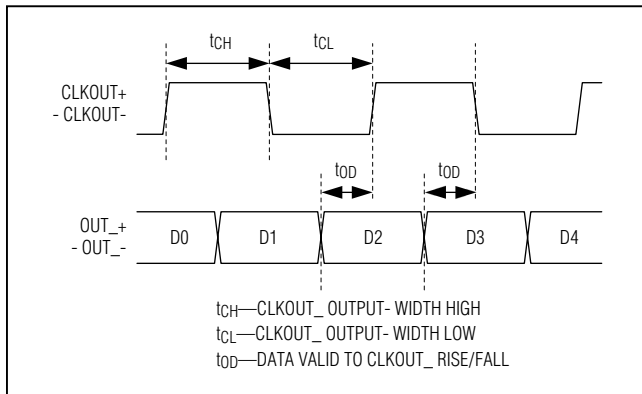


Figure 19. Serial Output Detailed Timing Diagram

Clock Output (CLKOUT+, CLKOUT-)

The ADC provides a differential clock output that consists of CLKOUT+ and CLKOUT-. As shown in [Figure 19](#), the serial-output data is clocked out of the device on both edges of the clock output. The frequency of the output clock is six times (6x) the frequency of the input clock. The Output Data Format and Test Pattern/Digital HPF Select register (01h) allows the phase of the clock output to be adjusted relative to the output data frame ([Table 7](#), [Figure 21](#)).

Frame-Alignment Output (FRAME+, FRAME-)

The ADC provides a differential frame-alignment signal that consists of FRAME+ and FRAME-. As shown in [Figure 18](#), the rising edge of the frame-alignment signal corresponds to the first bit (D0) of the 12-bit serial-data stream. The frequency of the frame-alignment signal is identical to the frequency of the input clock; however, the duty cycle varies depending on the input clock frequency.

Serial-Output Data (OUT+, OUT-)

The ADC provides conversion results through individual differential outputs consisting of OUT+ and OUT-. The results are valid 10.5 input clock cycles after a sample is taken. As shown in [Figure 19](#), the output data is clocked out on both edges of the output clock, LSB (D0) first (by default). [Figure 18](#) displays the detailed serial-output timing diagram.

Differential LVDS Digital Outputs

The ADC features programmable, fully differential LVDS digital outputs. By default, the 12-bit data output is transmitted LSB first, in offset binary format. The Output Data Format and Test Pattern/Digital HPF Select register (01h, [Table 7](#)) allows customization of the output bit order and data format. The output bit order can be reconfigured to transmit MSB first, and the output data format can be

changed to two's complement. [Table 8](#) contains full output data configuration details.

The LVDS outputs feature flexible programming options. First, the output common-mode voltage can be programmed from 0.6V to 1.2V (default) in 200mV steps ([Table 15](#)). Use the LVDS Output Driver Level register (02h, [Table 11](#)) to adjust the output common-mode voltage.

The LVDS output driver current is also fully programmable through the LVDS Output Driver Management register (03h, [Table 16](#)). By default, the output driver current is set to 3.5mA. The output driver current can be adjusted from 0.5mA to 7.5mA in 0.5mA steps ([Table 17](#)).

The LVDS output drivers also feature optional internal terminations that can be enabled and adjusted by the LVDS Output Driver Management register (03h, [Table 16](#)). By default, the internal output driver termination is disabled. See [Table 18](#) for all possible configurations.

Output Driver Level Tests

The LVDS outputs (data, clock, and frame) can be configured to static logic-level test states through the LVDS Output Driver Level register (02h, [Table 11](#)). The complete list of settings for the static logic-level test states can be found in [Tables 12](#), [13](#), and [14](#).

Data Output Test Patterns

The LVDS data outputs can be configured to output several different, recognizable test patterns. Test patterns are enabled and selected using the Output Data Format and Test Pattern/Digital HPF Select register (01h, [Table 7](#)). A complete list of test pattern options are listed in [Table 9](#), and custom test pattern details can be found in the Custom Test Pattern registers (07h, 08h, 09h) section (including [Tables 24](#), [27](#), and [28](#)).

Power Management

The SHDN input is used to toggle between two power-management states. Power state 0 corresponds to SHDN = 0, while power state 1 corresponds to SHDN = 1. The PLL Sampling Rate and Power Management register (00h) and the Channel Power Management registers (05h and 06h) fully define each power-management state. By default, SHDN = 1 shuts down the device, and SHDN = 0 returns the ADCs to full-power operation. Use of the SHDN input is not required for power management.

For either state of SHDN, complete power-management flexibility is provided, including individual ADC channel power-management control, as well as the option of which reduced power-mode to utilize in each power state. The reduced-power modes available are

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

sleep mode and nap mode. The device cannot enter either of these states unless no ADC channels are active in the current power state (Table 6).

In nap mode, the reference, duty-cycle equalizer, and clock-multiplier PLL circuits remain active for rapid wake-up time. In nap mode, the externally applied clock signal must remain active for the duty-cycle equalizer and PLL to remain locked. Typical wake-up time from nap mode is 2μs.

In sleep mode, all circuits are turned off except for the bandgap voltage-generation circuit. All registers retain previously programmed values during sleep mode. Typical wake-up time from sleep mode is 2ms (typ).

Power-On and Reset

The user-programmable register default settings and other factory-programmed settings are stored in a non-volatile memory. Upon device power-up, these values are loaded into the control registers. The operation occurs after the application of a valid supply voltage to AVDD and OVDD, and the presence of an input clock signal. The user-programmed register values are retained as long as the AVDD and OVDD voltages are applied.

A reset condition overwrites all user-programmed registers with the factory-default values. The reset condition occurs on power-up and can be initiated while powered with a software write command (write 5Ah) through the serial-port interface to the Special Function register (10h). The reset time is proportional to the ADC clock period and requires 415μs at 50Msps.

Power-Down and Low-Power (Nap) Mode and Channel Selection

The SHDN pin is a toggle switch between any two power-management states. In most cases, the SHDN = 0 state is on, and the SHDN = 1 state is off. However, complete flexibility is provided, allowing the user to toggle between active and nap, active and sleep, etc. Nap mode is defined as a reduced-power state with rapid wake-up time on the order of 2μs. Sleep mode is a very-low-power mode (~1mW) with a much longer wake-up time on the order of 2ms. The serial port and programmable registers remain active during nap and sleep modes.

CHn_ON_SHDN0 n = [1:8]

- 1 Channel n is on when the SHDN pin is low.
- 0 Channel n is off when the SHDN pin is low.

CHn_ON_SHDN1 n = [1:8]

- 1 Channel n is on when the SHDN pin is high.
- 0 Channel n is off when the SHDN pin is high.

ADC_NAP_SHDN0

- 1 ADC in nap mode when all channels are off, or the CWD pin is high and the SHDN pin is low.
- 0 ADC in sleep mode when all channels are off, or the CWD pin is high and the SHDN pin is low.

ADC_NAP_SHDN1

- 1 ADC in nap mode when all channels are off, or the CWD pin is high and the SHDN pin is high.
- 0 ADC in sleep mode when all channels are off, or the CWD pin is high and the SHDN pin is high.

AFE_NAP_SHDN0

- 1 AFE in nap mode when all channels are off and the SHDN pin is low.
- 0 AFE in sleep mode when all channels are off and the SHDN pin is low.

AFE_NAP_SHDN1

- 1 AFE in nap mode when all channels are off and the SHDN pin is high.
- 0 AFE in sleep mode when all channels are off and the SHDN pin is high.

3-Wire Serial Peripheral Interface (SPI)

The ADC operates as a slave device that sends and receives data through a 3-wire SPI interface. A master device must initiate all data transfers to and from the device. The device uses an active-low SPI chip-select input (\overline{CS}) to enable communication with timing controlled through the externally generated SPI clock input (SCLK). All data is sent and received through the bidirectional SPI data line (SDIO). The device has 16 user-programmable control registers and one special-function register, which are accessed and programmed through this interface.

SPI Communication Format

Figure 20 shows an ADC SPI communication cycle. All SPI communication cycles are made up of 2 bytes of data on SDIO and require 16 clock cycles on SCLK to be completed. To initiate an SPI read or write communication cycle, \overline{CS} must first transition from a logic-high to a logic-low state. While \overline{CS} remains low, serial data is clocked in from SDIO on rising edges of SCLK, and clocked out (for a read) on the falling edges of SCLK. When \overline{CS} is high, the device does not respond to SCLK transitions, and no data is read from or written to SDIO. \overline{CS} must transition back to logic-high after each read/write cycle is completed.

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

The first byte transmitted on SDIO is always provided by the master. The ADC (slave device) clocks in the data from SDIO on each rising edge of SCLK. The first bit received selects whether the communication cycle is a read or a write. Logic 1 selects a read cycle, while logic 0 selects a write cycle. The next 7 bits (MSB first) are the register address for the read or write cycle. The address can indicate any of the 16 user-programmable control registers (00h to 0Fh), or the special-function register (10h, write only). Attempting to read/write with any other address has no effect ([Table 3](#)).

The second byte on SDIO is sent to the ADC in the case of a write, or received from the ADC in the case of a read. For a write command, the device continues to clock in the data on SDIO on each rising edge of SCLK. In the case of a read command, the device writes data to SDIO on each falling edge of SCLK. The data byte is transmitted and received MSB first in both cases. The detailed SPI timing requirements are shown in [Figure 20](#).

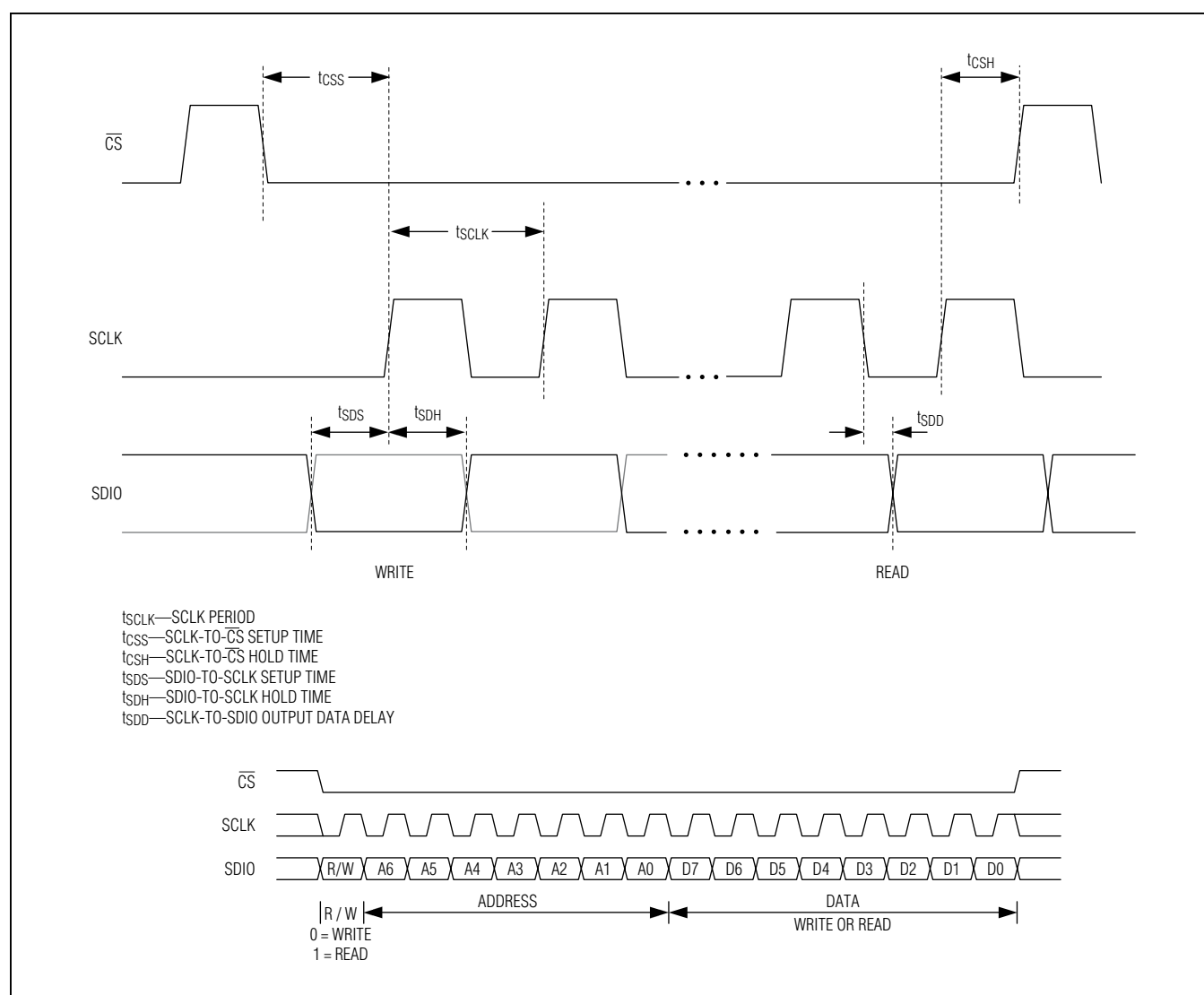


Figure 20. SPI Timing Diagram

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Table 3. User-Programmable ADC Control Registers

| ADDRESS | READ/WRITE | POR STATE | FUNCTION |
|---------|------------|-----------|--|
| 00h | R/W | 0001-0001 | PLL Sampling Rate and Power Management |
| 01h | R/W | 0000-0000 | Output Data Format and Test Pattern/Digital HPF Select |
| 02h | R/W | 0000-0000 | LVDS Output Driver Level |
| 03h | R/W | 0000-0000 | LVDS Output Driver Management |
| 04h | R/W | 0000-0000 | ADC CLKIN Control |
| 05h | R/W | 1111-1111 | Channel Power Management: SHDN0 |
| 06h | R/W | 0000-0000 | Channel Power Management: SHDN1 |
| 07h | R/W | 0100-0100 | Digital HPF 1 and 2 -3dB Cutoff/Custom Test Patterns 1 |
| 08h | R/W | 0101-0110 | Digital HPF 1 and Attenuation/Custom Test Patterns 2 |
| 09h | R/W | 0101-1010 | Custom Test Patterns 2 and 1 (4msbs) |
| 0Ah | R/W | 0101-1100 | AFE Settings |
| 0Bh | R/W | 0000-0000 | CW Beamformer 1 |
| 0Ch | R/W | 0000-0000 | CW Beamformer 2 |
| 0Dh | R/W | 0000-0000 | CW Beamformer 3 |
| 0Eh | R/W | 0000-0000 | CW Beamformer 4 |
| 0Fh | R/W | 0000-0000 | CW Beamformer 5 |
| 10h | R/W | N/A | Special Function |

Table 4. PLL Sampling Rate and Power Management (00h)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|----------|-------|-------|---------------|---------------|---------------|---------------|
| — | PLL[2:0] | | | AFE_NAP_SHDN1 | AFE_NAP_SHDN0 | ADC_NAP_SHDN1 | ADC_NAP_SHDN0 |

Table 5. PLL Frequency-Control Settings (00h[6:4])

| CLOCK MULTIPLIER SETTING | | | MINIMUM SAMPLING FREQUENCY (MHz) | MAXIMUM SAMPLING FREQUENCY (MHz) |
|--------------------------|--------|--------|-------------------------------------|-------------------------------------|
| PLL[2] | PLL[1] | PLL[0] | | |
| 0 | 0 | 0 | Not used | |
| 0 | 0 | 1 | 39 | 50 |
| 0 | 1 | 0 | 28.5 | 39 |
| 0 | 1 | 1 | 25 | 28.8 |
| 1 | X | X | Not used | |

X = Don't care.

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Table 6. Power-Management Programming

| PINS | | REGISTERS | | | | | | DESCRIPTION |
|---------------------------|-----|--|--|---------------|---------------|---------------|---------------|--------------------------------------|
| SHDN | CWD | CHn_ON_SHDN0 n = [1:8] | CHn_ON_SHDN1 n = [1:8] | ADC_NAP_SHDN0 | ADC_NAP_SHDN1 | AFE_NAP_SHDN0 | AFE_NAP_SHDN1 | |
| | | | | | | | | |
| DEFAULT REGISTER MODES | | | | | | | | |
| 0 | 0 | 11111111 | 00000000 | 0 | 1 | 0 | 1 | 8 channels active (VGA mode) |
| 0 | 1 | 11111111 | 00000000 | 0 | 1 | 0 | 1 | CW Doppler mode (ADC in nap mode) |
| 1 | 0 | 11111111 | 00000000 | 0 | 1 | 0 | 1 | Nap mode (ADC and AFE) |
| 1 | 1 | 11111111 | 00000000 | 0 | 1 | 0 | 1 | CW Doppler mode (ADC in nap mode) |
| PROGRAMMED REGISTER MODES | | | | | | | | |
| 0 | 0 | 1XXXXXXX X1XXXXXX XX1XXXXX XXX1XXXX XXXX1XXX XXXXX1XX XXXXXX1X XXXXXXX1 | XXXXXXXX | X | X | X | X | 1 or more channels active (VGA mode) |
| 0 | 0 | 00000000 | XXXXXXXX | 0 | X | 0 | X | Sleep mode (ADC and AFE) |
| 0 | 0 | 00000000 | XXXXXXXX | 0 | X | 1 | X | ADC sleep/AFE nap |
| 0 | 0 | 00000000 | XXXXXXXX | 1 | X | 0 | X | ADC nap/AFE sleep |
| 0 | 0 | 00000000 | XXXXXXXX | 1 | X | 1 | X | Nap mode (ADC and AFE) |
| 0 | 1 | XXXXXXXX | XXXXXXXX | 0 | X | X | X | CW Doppler mode (ADC in sleep mode) |
| 0 | 1 | XXXXXXXX | XXXXXXXX | 1 | X | X | X | CW Doppler mode (ADC in nap mode) |
| 1 | 0 | XXXXXXXX | 1XXXXXXX X1XXXXXX XX1XXXXX XXX1XXXX XXXX1XXX XXXXX1XX XXXXXX1X XXXXXXX1 | X | X | X | X | 1 or more channels active (VGA mode) |
| 1 | 0 | XXXXXXXX | 00000000 | X | 0 | X | 0 | Sleep mode (ADC and AFE) |
| 1 | 0 | XXXXXXXX | 00000000 | X | 0 | X | 1 | ADC sleep/AFE nap |
| 1 | 0 | XXXXXXXX | 00000000 | X | 1 | X | 0 | ADC nap/AFE sleep |
| 1 | 0 | XXXXXXXX | 00000000 | X | 1 | X | 1 | Nap mode (ADC and AFE) |
| 1 | 1 | XXXXXXXX | XXXXXXXX | X | 0 | X | X | CW Doppler mode (ADC in sleep mode) |
| 1 | 1 | XXXXXXXX | XXXXXXXX | X | 1 | X | X | CW Doppler mode (ADC in nap mode) |

X = Don't care.

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Table 7. Output Data Format and Test Pattern/Digital HPF Select (01h)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------------------|-------|-------|-----------|-------------------|-------|-------------|-----------|
| TEST_PATTERN[2:0] | | | TEST_DATA | CLKOUT_PHASE[1:0] | | DATA_FORMAT | BIT_ORDER |

Table 8. LVDS Output Data Format Programming

| DATA_FORMAT | BIT_ORDER | LVDS OUTPUT DATA FORMAT |
|-------------|-----------|-----------------------------|
| 0 | 0 | Binary, LSB first (default) |
| 0 | 1 | Binary, MSB first |
| 1 | 0 | Two's complement, LSB first |
| 1 | 1 | Two's complement, MSB first |

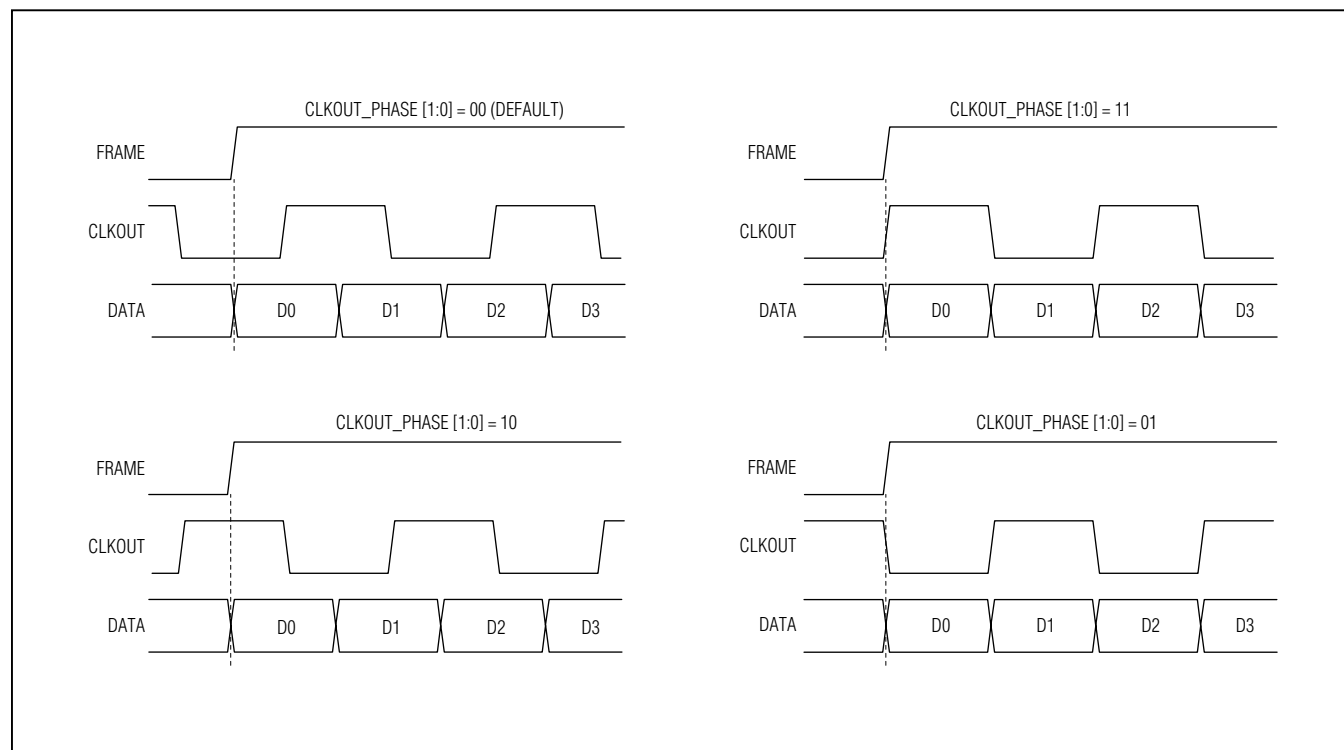


Figure 21. Output Clock Phase

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Table 9. Test Pattern Programming and Digital Highpass Filter Selection

| TEST_DATA | TEST_PATTERN[2:0] | | | TEST PATTERN FORMAT |
|-----------|-------------------|---|---|--|
| 0 | X | X | X | Disabled, normal operation with digital HPF selected (default) |
| 1 | 0 | 0 | 0 | Data skew (010101010101), repeats every frame |
| 1 | 0 | 0 | 1 | Data sync (111111000000), repeats every frame |
| 1 | 0 | 1 | 0 | Custom test pattern, repeats every 2 frames |
| 1 | 0 | 1 | 1 | Ramping pattern from 0 to 4095 (repeats) |
| 1 | 1 | 0 | 0 | Pseudorandom data pattern, short sequence (2 ⁹) |
| 1 | 1 | 0 | 1 | Pseudorandom data pattern, long sequence (2 ²³) |
| 1 | 1 | 1 | 0 | Not used |
| 1 | 1 | 1 | 1 | Not used |

X = Don't care.

Custom Test Pattern

When custom test pattern is selected (TEST_PATTERN[2:0] = 010), the output alternates between BITS_CUSTOM1[11:0] and BITS_CUSTOM2[11:0]. If a single repeating word is desired, program BITS_CUSTOM2[11:0] to the same value as BITS_CUSTOM1[11:0].

Table 10. Pseudorandom Data Test Pattern

(When custom test pattern is selected (TEST_PATTERN[2:0] = 100) the output is a short (2⁹) PN sequence. A long (2²³) sequence output is provided when TEST_PATTERN[2:0] = 101.)

| SEQUENCE | INITIAL VALUE | FIRST 3 SAMPLES |
|-------------------------|---------------|---------------------|
| Short (2 ⁹) | 0x0df | 0xdf9, 0x353, 0x301 |
| Long (2 ²³) | 0x29b80a | 0x591, 0xfd7, 0x0a3 |

Table 11. LVDS Output Driver Level (02h)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|--------------|-------|-----------------------|-------|------------------------|-------|----------------------|-------|
| LVDS_CM[1:0] | | TEST_FRAME_LEVEL[1:0] | | TEST_CLKOUT_LEVEL[1:0] | | TEST_DATA_LEVEL[1:0] | |

Table 12. Test Data (OUT_) Level Programming

| TEST_DATA_LEVEL[1:0] | DATA (OUT_) OUTPUT |
|----------------------|----------------------|
| X 0 | Normal data output |
| 0 1 | Output low (static) |
| 1 1 | Output high (static) |

X = Don't care.

Table 13. Test CLKOUT_ Level Programming

| TEST_CLKOUT_LEVEL[1:0] | CLKOUT_ OUTPUT |
|------------------------|-----------------------|
| X 0 | Normal CLKOUT_ output |
| 0 1 | Output low (static) |
| 1 1 | Output high (static) |

X = Don't care.

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Table 14. Test FRAME Level Programming

| TEST_FRAME_LEVEL[1:0] | | FRAME OUTPUT |
|-----------------------|---|----------------------|
| X | 0 | Normal FRAME output |
| 0 | 1 | Output low (static) |
| 1 | 1 | Output high (static) |

X = Don't care.

Table 15. LVDS Output Common-Mode Voltage Adjustment

| LVDS_CM[1:0] | | LVDS OUTPUT COMMON-MODE VOLTAGE (V) |
|--------------|---|-------------------------------------|
| 0 | 0 | 1.2 (default) |
| 0 | 1 | 1.0 |
| 1 | 0 | 0.8 |
| 1 | 1 | 0.6 |

Table 16. LVDS Output Driver Management (03h)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|----------------|-------|-------|----------------|-------|-------|-------|
| — | LVDS_TERM[2:0] | | | LVDS_IADJ[3:0] | | | |

Table 17. LVDS Output Drive Current Configuration

(Selectable LVDS drive current fully selectable from 0.5mA to 7.5mA in 0.5mA increments (3.5mA default). Supports ANSI-644 and IEEE 1596.3.)

| LVDS_IADJ[3:0] | | | | LVDS CURRENT (mA) |
|----------------|---|---|---|--------------------------------|
| 0 | 0 | 0 | 0 | 3.5mA, 350mV at 100Ω (default) |
| 0 | 0 | 0 | 1 | 0.5 |
| 0 | 0 | 1 | 0 | 1.0 |
| 0 | 0 | 1 | 1 | 1.5 |
| 0 | 1 | 0 | 0 | 2.0 |
| 0 | 1 | 0 | 1 | 2.5 |
| 0 | 1 | 1 | 0 | 3.0 |
| 0 | 1 | 1 | 1 | 3.5 |
| 1 | 0 | 0 | 0 | 4.0 |
| 1 | 0 | 0 | 1 | 4.5 |
| 1 | 0 | 1 | 0 | 5.0 |
| 1 | 0 | 1 | 1 | 5.5 |
| 1 | 1 | 0 | 0 | 6.0 |
| 1 | 1 | 0 | 1 | 6.5 |
| 1 | 1 | 1 | 0 | 7.0 |
| 1 | 1 | 1 | 1 | 7.5 |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Table 18. LVDS Output Driver Internal Termination Configuration

| LVDS_TERM[2:0] | | | LVDS INTERNAL TERMINATION (Ω) |
|----------------|---|---|--|
| 0 | 0 | 0 | — |
| 0 | 0 | 1 | 800 |
| 0 | 1 | 0 | 400 |
| 0 | 1 | 1 | 267 |
| 1 | 0 | 0 | 200 |
| 1 | 0 | 1 | 160 |
| 1 | 1 | 0 | 133 |
| 1 | 1 | 1 | 100 |

Table 19. CLKIN Termination Control (04h)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------|-------|------------|-------|-------|-------|-------|
| — | — | — | CLKIN_TERM | — | — | — | 0 |

Bit 0

Clock Input Termination

Always program this bit to 0.

CLKIN_TERM = 0: 100 Ω not selected.

CLKIN_TERM = 1: Switches in 100 Ω across differential clock inputs.

Table 20. Channel Power Management: SHDN0 (05h)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| CH8_SHDN0 | CH7_SHDN0 | CH6_SHDN0 | CH5_SHDN0 | CH4_SHDN0 | CH3_SHDN0 | CH2_SHDN0 | CH1_SHDN0 |

Table 21. Channel Power Management: SHDN1 (06h)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| CH8_SHDN1 | CH7_SHDN1 | CH6_SHDN1 | CH5_SHDN1 | CH4_SHDN1 | CH3_SHDN1 | CH2_SHDN1 | CH1_SHDN1 |

Table 22. Digital Highpass Filter Control Coefficients (07h; If TEST_DATA 01[4] = 0)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-----------|-------|-------|-------|-----------|-------|-------|-------|
| HPF2[3:0] | | | | HPF1[3:0] | | | |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Table 23. Digital Highpass Filter Configuration

| HPF1[3:0], HPF2[3:0] | | | | R1/R2 | FILTER MODE |
|----------------------|---|---|---|-------|-------------------------------------|
| 0 | 0 | 0 | 0 | N/A | Bypass |
| 0 | 0 | 0 | 1 | 63/64 | Filter; $f_{3dB} = 0.004935, f_s/2$ |
| 0 | 0 | 1 | 0 | 62/64 | Filter; $f_{3dB} = 0.009796, f_s/2$ |
| 0 | 0 | 1 | 1 | 61/64 | Filter; $f_{3dB} = 0.014584, f_s/2$ |
| 0 | 1 | 0 | 0 | 60/64 | Filter; $f_{3dB} = 0.019303, f_s/2$ |
| 0 | 1 | 0 | 1 | 59/64 | Filter; $f_{3dB} = 0.023956, f_s/2$ |
| 0 | 1 | 1 | 0 | 58/64 | Filter; $f_{3dB} = 0.028544, f_s/2$ |
| 0 | 1 | 1 | 1 | 57/64 | Filter; $f_{3dB} = 0.033069, f_s/2$ |
| 1 | 0 | 0 | 0 | 56/64 | Filter; $f_{3dB} = 0.037535, f_s/2$ |
| 1 | 0 | 0 | 1 | 55/64 | Filter; $f_{3dB} = 0.041943, f_s/2$ |
| 1 | 0 | 1 | 0 | 54/64 | Filter; $f_{3dB} = 0.046294, f_s/2$ |
| 1 | 0 | 1 | 1 | N/A | Bypass |
| 1 | 1 | 0 | 0 | N/A | Bypass |
| 1 | 1 | 0 | 1 | N/A | Bypass |
| 1 | 1 | 1 | 0 | N/A | Bypass |
| 1 | 1 | 1 | 1 | N/A | Bypass |

Table 24. Custom Test Pattern 1 (07h; If TEST_DATA 01[4] = 1)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------------------|-------|-------|-------|-------|-------|-------|-------|
| BITS_CUSTOM1[7:0] | | | | | | | |

Table 25. Digital Highpass Filter Attenuation (08h; If TEST_DATA 01[4] = 0)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------|-------|-------|-------|-------|------------|-------|
| — | — | — | — | — | — | ATTEN[1:0] | |

Table 26. Digital Highpass Filter Attenuation

| ATTEN[1:0] | | GAIN | GAIN (dB) |
|------------|---|-------|-----------|
| 0 | 0 | 1 | 0 |
| 0 | 1 | 1 | 0 |
| 1 | 0 | 15/16 | -0.58 |
| 1 | 1 | 7/8 | -1.16 |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Table 27. Custom Test Pattern 2 (08h; If TEST_DATA 01[4] = 1)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------------------|-------|-------|-------|-------|-------|-------|-------|
| BITS_CUSTOM2[7:0] | | | | | | | |

Table 28. Custom Test Pattern 3 (09h)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|--------------------|-------|-------|-------|--------------------|-------|-------|-------|
| BITS_CUSTOM2[11:8] | | | | BITS_CUSTOM1[11:8] | | | |

Table 29. AFE Settings (0Ah)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|--------------|-------|-------|--------------|-------------|-------|----------------|------------|
| AFE_RIN[0:2] | | | AFE_LNA_GAIN | AFE_BW[0:1] | | CWD_POWER_MODE | AFE_OCLAMP |

Table 30. AFE Input Impedance and LNA Gain Control

| AFE_LNA_GAIN | AFE_RIN[0:2] | | | INPUT RESISTANCE (Ω) | LNA GAIN (dB) |
|--------------|--------------|---|---|----------------------------------|------------------|
| 0 | 0 | 0 | 0 | 100 | 12.5 |
| 0 | 1 | 0 | 0 | 200 | 12.5 |
| 0 | 0 | 1 | 0 | 400 | 12.5 |
| 0 | 1 | 1 | 0 | 2000 | 12.5 |
| 0 | X | X | 1 | External R | 12.5 |
| 1 | 0 | 0 | 0 | 50 | 18.5 |
| 1 | 1 | 0 | 0 | 100 | 18.5 |
| 1 | 0 | 1 | 0 | 200 | 18.5 |
| 1 | 1 | 1 | 0 | 1000 | 18.5 |
| 1 | X | X | 1 | External R | 18.5 |

X = Don't care.

Table 31. AFE Filter Bandwidth Control

| AFE_BW[0:1] | BANDWIDTH (MHz) |
|-------------|-----------------|
| 0 | 9 |
| 0 | 10 |
| 1 | 15 |
| 1 | 18 |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Table 32. CWD Power Mode

| CWD_POWER_MODE | CWD POWER MODE |
|----------------|-------------------------------|
| 0 | Full power (default, nominal) |
| 1 | Low power |

Table 33. VGA Output Clamp Control

| AFE_OCLAMP | VGA OUTPUT CLAMP |
|------------|-----------------------------|
| 0 | No clamp (default, nominal) |
| 1 | Clamp active |

Table 34. CW Beamformer 1 (0Bh)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------------------|-------|-------|-------------|-------------------|-------|-------|-------|
| CW_PHASE_CH2[1:3] | | | CW_SHDN_CH1 | CW_PHASE_CH1[0:3] | | | |

Table 35. CW Beamformer 2 (0Ch)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-----------------|-------------|-------------------|-------|-------|-------------|-----------------|-------|
| CW_PHASE_CH4[3] | CW_SHDN_CH3 | CW_PHASE_CH3[0:3] | | | CW_SHDN_CH2 | CW_PHASE_CH2[0] | |

Table 36. CW Beamformer 3 (0Dh)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------------------|-------|-------|-------------|-------------------|-------|-------|-------|
| CW_PHASE_CH5[0:3] | | | CW_SHDN_CH4 | CW_PHASE_CH4[0:2] | | | |

Table 37. CW Beamformer 4 (0Eh)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------------------|-------------|-------------------|-------|-------|-------|-------------|-------|
| CW_PHASE_CH7[2:3] | CW_SHDN_CH6 | CW_PHASE_CH6[0:3] | | | | CW_SHDN_CH5 | |

Table 38. CW Beamformer 5 (0Fh)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------------|-------------------|-------|-------|-------|-------------|-------------------|-------|
| CW_SHDN_CH8 | CW_PHASE_CH8[0:3] | | | | CW_SHDN_CH7 | CW_PHASE_CH7[0:1] | |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

CW Doppler Mode Control

CW_SHDN_CHn is set to 0 in normal operation (default). Set it to 1 for power-down channel n when in CW Doppler mode.

Note: The transfer data to AFE procedure described in the [AFE Programming and Data Transfer](#) section should be performed twice when setting any CW_SHDN_CHn bits from 0 to 1 to enable a CW Doppler channel(s). This procedure only applies to the CW_SHDN_CHn bits; all other bits are transferred to the AFE in a single operation.

Table 39. Degree Change by Each Phase Bit

| PH[0] | PH[1] | PH[2] | PH[3] | PHASE |
|-------|-------|-------|-------|---------|
| -22.5 | -180 | -90 | -45 | Degrees |

Table 40. Phase Rotation

| CW_PHASE_CHn[0:3] | | | | PHASE (Degrees) |
|-------------------|------|-----|-----|--------------------|
| -22.5 | -180 | -90 | -45 | |
| 0 | 0 | 0 | 0 | 0 |
| 1 | 0 | 0 | 0 | 337.5 |
| 0 | 1 | 0 | 0 | 180 |
| 1 | 1 | 0 | 0 | 157.5 |
| 0 | 0 | 1 | 0 | 270 |
| 1 | 0 | 1 | 0 | 247.5 |
| 0 | 1 | 1 | 0 | 90 |
| 1 | 1 | 1 | 0 | 67.5 |
| 0 | 0 | 0 | 1 | 315 |
| 1 | 0 | 0 | 1 | 292.5 |
| 0 | 1 | 0 | 1 | 135 |
| 1 | 1 | 0 | 1 | 112.5 |
| 0 | 0 | 1 | 1 | 225 |
| 1 | 0 | 1 | 1 | 202.5 |
| 0 | 1 | 1 | 1 | 45 |
| 1 | 1 | 1 | 1 | 22.5 |

Table 41. Special Function Register (10h)

| BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|---------|---------|---------|---------|---------|---------|---------|---------|
| STATUS7 | STATUS6 | STATUS5 | STATUS4 | STATUS3 | STATUS2 | STATUS1 | STATUS0 |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Table 42. Status Byte (Reads from 10h)

| STATUS BIT NO. | READ VALUE | DESCRIPTION |
|----------------|------------|--|
| 7 | 0 | Reserved |
| 6 | 0 | 1 = AFE load in progress; 0 = load complete |
| 5 | 0 or 1 | 1 = ROM read in progress |
| 4 | 0 or 1 | 1 = ROM read completed, and register data is valid (checksum ok) |
| 3 | 0 | Reserved |
| 2 | 1 | Reserved |
| 1 | 0 or 1 | Reserved |
| 0 | 0 or 1 | 1 = Duty-cycle equalizer DLL is locked |

Table 43. SPI Commands (Writes to 10h)

(All commands are issued by writing SPI address 10h.)

| COMMAND | WRITE DATA | DESCRIPTION |
|----------------------|------------|---|
| Soft reset | 5Ah | Initiates software reset |
| Transfer data to AFE | A Eh | Initiates transfer of data in ADC registers 0Ah to 0Fh to AFE |

Soft Reset

Software reset allows the user to reset the part through writes to the serial port. A soft reset can be performed by writing the reset code 5Ah to address 10h. Upon initiation of soft reset, the fuse memory is read and loaded into the SPI registers. See the [3-Wire Serial Peripheral Interface \(SPI\)](#) section for further detail. The reset is self-clearing, subsequent serial-port write(s) are not needed to clear the reset condition.

AFE Programming and Data Transfer

The internal analog front-end (AFE) and ADC are programmed through a common serial-port interface. There are 48 user-programmable bits in the ADC that store AFE control information. These bits are written to registers 0Ah to 0Fh in the ADC, and transferred to the AFE shift registers when AEh is written to register 10h. The user must provide at least 50 clock cycles on SCLK after this control word is written to complete the data transfer to the AFE. To verify that the data has been transferred to the AFE, poll address 10h until bit 6 is 0. As a final step, write 00h to address 10h. Changes in registers 0Ah to 0Fh do not take effect in the AFE until this transfer is complete.

CWD Beamformer Programming and Clocking

Programming of the CWD beamformer occurs in the following sequence:

- 1) During normal CWD mode, the mixer clock (LO+, LO-) is on. LOON is high.
- 2) Shut off the mixer clock (LO+, LO-) or pull LOON low to start the programming sequence.
- 3) Write the phase and channel shutdown information into the proper control registers.
- 4) Transfer the phase information from the control registers to the AFE (see above) and wait for the write to complete. Turn on the mixer clock and set LOON to high to start beamforming (the AFE shift registers can also be written with the mixer clock running and LOON set low). If turning on the mixer clock source, the clock must turn on such that it starts at the beginning of a mixer clock cycle. A narrow glitch on the mixer clock is not acceptable and could cause metastability in the I/Q phase dividers. If using the LOON control to turn on the mixer clock, the LOON signal must be synchronous to the LO clock, and it must meet the minimum setup time specification.

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

- 5) To program new CWD phase information, turn off the mixer clock and/or set LOON low and repeat steps 1–5.
- 6) For switching between VGA and CWD modes without reprogramming the SPI registers (fast-mode switching): When changing from CWD mode to VGA mode, nothing needs to be done to maintain the AFE programming settings. When switching from VGA mode to CWD mode, the user must provide a CS pulse after the CWD pin goes high to initialize the CWD beamformer phase registers. This pulse must occur 100ns or more after the rising edge of the CWD pin, and must be at least 80ns in width.

Applications Information

Ultrasound-Specific IMD3 Specification

Unlike typical communications applications, the two input tones are not equal in magnitude for the ultrasound-specific IMD3 two-tone specification. In this measurement, f_1 represents reflections from tissue and f_2 represents reflections from blood. The latter reflections are typically 25dB lower in magnitude. IM3 performance for the device is measured with the smaller tone at -25dBc in order to more accurately resolve the small IM3 products

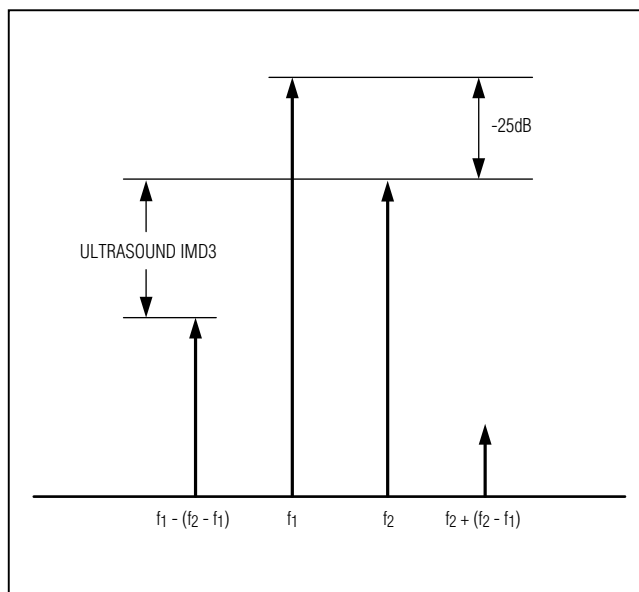


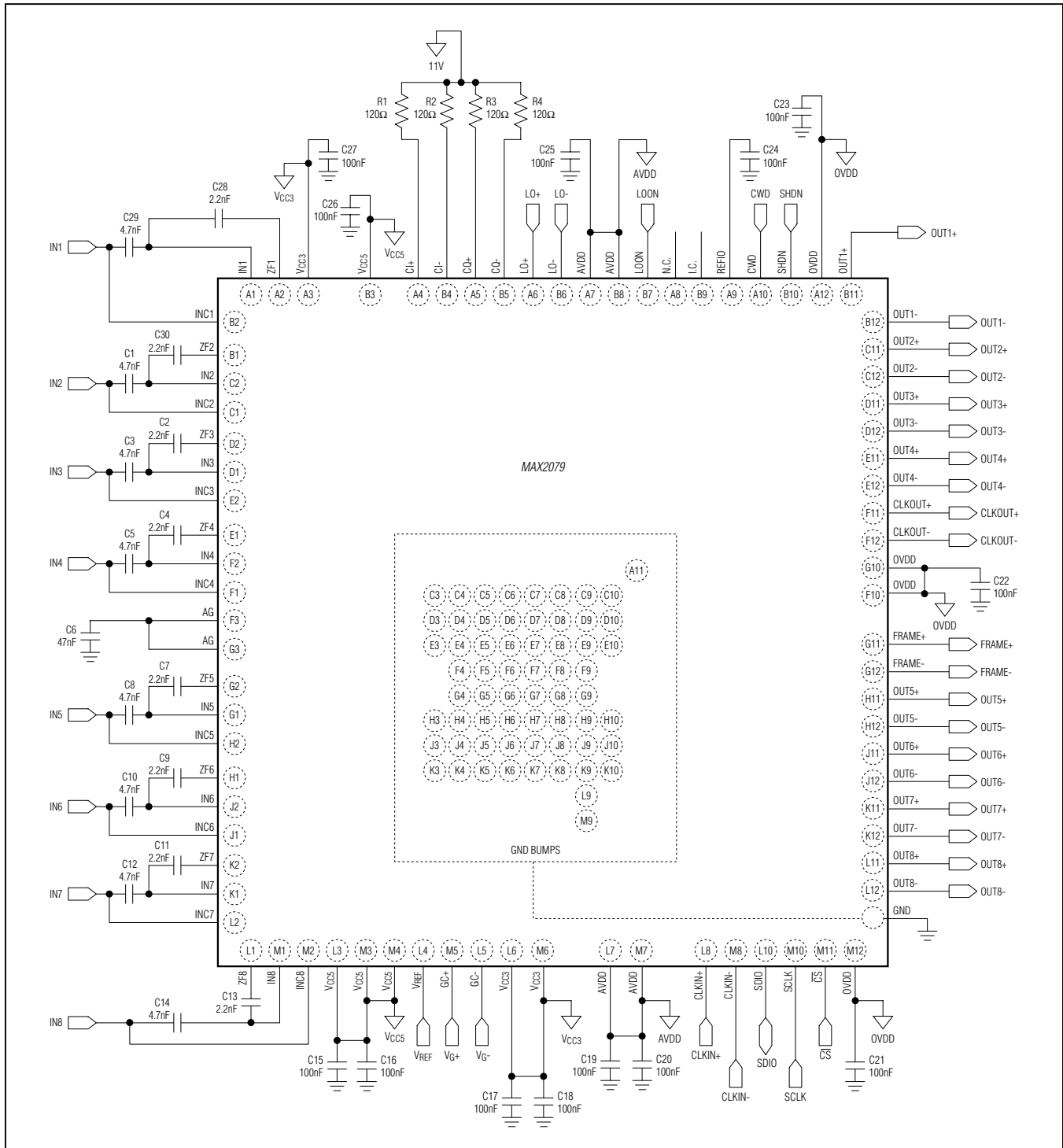
Figure 22. Ultrasound-Specific IMD3

over the thermal noise floor. The IMD3 product of interest ($f_1 - (f_2 - f_1)$) presents itself as an undesired Doppler error signal in ultrasound applications (see [Figure 22](#)).

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Typical Application Circuit



MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Chip Information

PROCESS: BiCMOS/CMOS

Ordering Information

| PART | TEMP RANGE | BUMP-PACKAGE |
|--------------|--------------|--------------|
| MAX2079CXE+ | 0°C to +70°C | 144 CTBGA |
| MAX2079CXE+T | 0°C to +70°C | 144 CTBGA |

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE TYPE | PACKAGE CODE | OUTLINE NO. | LAND PATTERN NO. |
|--------------|--------------|-------------------------|-------------------------|
| 144 CTBGA | X14400M+1 | 21-0492 | 90-0347 |

MAX2079

Low-Power, High-Performance, Fully Integrated Octal Ultrasound Receiver (Octal LNA, VGA, AAF, ADC, and CWD Beamformer)

Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
|--------------------|------------------|--|------------------|
| 0 | 8/11 | Initial release | — |
| 1 | 10/12 | Fix errors and update <i>Typical Operating Characteristics</i> | |



Maxim Integrated cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim Integrated product. No circuit patent licenses are implied. Maxim Integrated reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.

Maxim Integrated 160 Rio Robles, San Jose, CA 95134 USA 1-408-601-1000

49



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.